

## **Multiple Input Switch Monitor LSI for Automotive**

#### BD3375KV-C

#### **General Description**

BD3375KV-C is a 22-channel Multiple Input Switch Monitor IC that detects the opening and closing of mechanical switches. Once it senses a change in the status of a switch, it sends an interrupt signal to the MCU via a serial peripheral interface (SPI).

The 22 switch inputs have two types of power supply, VPUB and VPUA. The VPUB and the VPUA power supplies can either be from a battery or from another power supply system. VPUB is the supply for the INB inputs while VPUA is for the INZ and INA inputs. BD3375KV-C has two modes of operation, Normal and

Sleep. In both modes, the internal registers can be set to make the device perform either intermittent or continuous monitoring of the switches.

In intermittent monitoring, the switch status is monitored at regular time intervals, allowing the IC to operate with low power consumption. Also, operation with reduced noise can be achieved by enabling uniform sequential monitoring of all switches or sequential monitoring by power supply system.

#### Application

**Engine Control Module** 

#### **Key Specifications**

- Fully Functional Voltage Range: -14V to +40V
- Switch Input Voltage Range:
- Selectable Wetting Current (Min):
  - 1mA, 3mA, 5mA, 10mA, 15mA

8V to 26V

#### Specifications

- AEC-Q100 Qualified (Note 1)
  - **Operational Voltage Range:** 3.9V to 8V
- Uses 3.3/5.0V SPI protocol in communicating with the MCU
- Serial communication error checking through 8bit-CRC
- Thermal Shutdown Protection (TSD)
- Power on Reset (POR)
- Selectable source/sink current levels through register settinas
- Wetting current timer capability
- 8 source or sink input terminals
- 14 source input terminals
- Separable Power Supply VPUA: 16ch (INA&INZ), VPUB: 6ch (INB)
- Interrupt notification upon switch status change
- 1 to 6 times matched LPF that eliminates input terminal noise
- Low current consumption (Intermittent monitoring)
- Status display of selected terminal at DMUX terminal (Note 1) Grade 1

VQFP48C (48 pin QFP)

## W(Typ) x D(Typ) x H(Max)

9.00mm x 9.00mm x 1.60mm



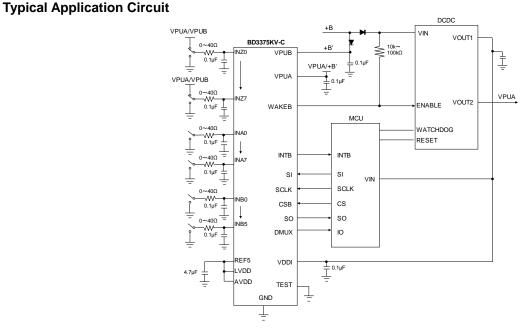
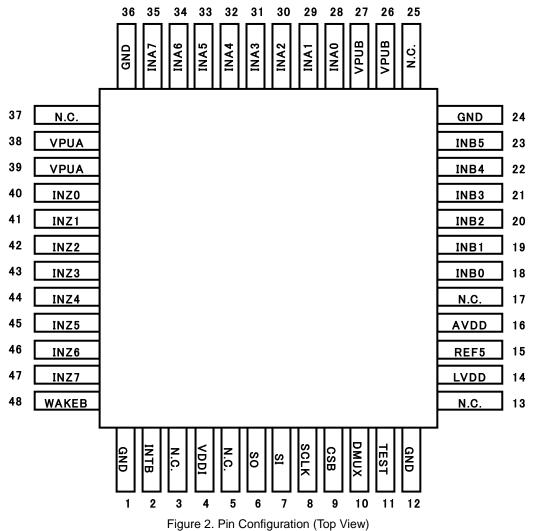


Figure 1. Typical Application Circuit

OProduct structure : Silicon monolithic integrated circuit OThis product has no designed protection against radioactive rays

# Package

#### **Pin Configuration**



#### **Pin Description**

Tahla '	1	Pin	Description	(1)	`
lable	١.		Describtion		)

	1			
Pin No.	Pin Name	Function	Description	Equivalent Circuit Diagram (Note 2)
1	GND	Ground	Ground pin	
2	INTB	Output	Open-drain interrupt output pin to the MCU (with an internal pull-down resistor)	С
3	N.C.	-	No Connection	
4	VDDI	Input	Power supply pin for CSB, SI, SCLK, SO, INTB and DMUX	
5	N.C.	-	No Connection	
6	SO	Output	SPI data output pin to the MCU	Н
7	SI	Input	SPI control data input pin from the MCU (with an internal pull-down resistor)	A
8	SCLK	Input	SPI control clock input pin from the MCU (with an internal pull-down resistor)	A
9	CSB	Input	SPI control chip select input pin from the MCU (with internal pull-up current source)	В
10	DMUX	Output	Digital multiplexer for switch input output pin	G
11	TEST	Input	Test mode control pin <sup>(Note 3)</sup>	J
12	GND	Ground	Ground	
13	N.C.	-	No Connection	
14	LVDD	Input	Power supply input pin for the logic block <sup>(Note 4)</sup> 5V power supply output pin <sup>(Note 4)</sup>	
15	REF5	Output	5V power supply output pin (Note 4)	I
16	AVDD	Input	Power supply input pin for the analog block (Note 4)	
17	N.C.	-	No Connection	
18	INB0	Input	Switch input pin 0 under VPUB power supply system (with an internal pull-up current source)	F
19	INB1	Input	Switch input pin 1 under VPUB power supply system (with an internal pull-up current source)	F
20	INB2	Input	Switch input pin 2 under VPUB power supply system (with an internal pull-up current source)	F
21	INB3	Input	Switch input pin 3 under VPUB power supply system (with an internal pull-up current source)	F
22	INB4	Input	Switch input pin 4 under VPUB power supply system (with an internal pull-up current source)	F
23	INB5	Input	Switch input pin 5 under VPUB power supply system (with an internal pull-up current source)	F
24	GND	Ground	Ground	
	-			1

(Note 3) Short TEST pin to ground when mounted. (Note 4) Short REF5 pin to AVDD pin and LVDD pin, and connect a 4.7µF capacitor between it and ground. Do not use it as voltage source to another IC.

Prin No.         Prin Name         Function         Description         Equivalent Circuit Diagram (NMS 2)           25         GND         -         No Connection         -           26         VPUB         Input         Power supply input pin for the main system and INB switches            27         VPUB         Input         Power supply input pin for the main system and INB switches            28         INA0         Input         Switch input pin 0 under VPUA power supply system         F           29         INA1         Input         Switch input pin 1 under VPUA power supply system         F           30         INA2         Input         Switch input pin 1 under VPUA power supply system         F           31         INA3         Input         Switch input pin 1 under VPUA power supply system         F           32         INA4         Input         Switch input pin 1 under VPUA power supply system         F           33         INA5         Input         Switch input pin 1 under VPUA power supply system         F           34         INA6         Input         Switch input pin 0 under VPUA power supply system         F           34         INA6         Input         Switch input pin 0 under VPUA power supply system         F				Table 2. Pin Description (2)	
26       VPUB       Input       Power supply input pin for the main system and INB switches          27       VPUB       Input       Power supply input pin for the main system and INB switches          28       INA0       Input       Switch input pin 0 under VPUA power supply system       F         29       INA1       Input       Switch input pin 1 under VPUA power supply system       F         30       INA2       Input       Switch input pin 2 under VPUA power supply system       F         31       INA3       Input       Switch input pin 3 under VPUA power supply system       F         31       INA3       Input       Switch input pin 4 under VPUA power supply system       F         32       INA4       Input       Switch input pin 4 under VPUA power supply system       F         33       INA5       Input       Switch input pin 5 under VPUA power supply system       F         34       INA6       Input       Switch input pin 7 under VPUA power supply system       F         35       INA7       Input       Switch input pin 7 under VPUA power supply system       F         35       INA7       Input       Switch input pin 1 under VPUA power supply system       F         36       GND       Ground       Ground			Function	Description	
27       VPUB       Input       Power supply input pin for the main system and INB switches          28       INA0       Input       Switch input pin 0 under VPUA power supply system       F         29       INA1       Input       Switch input pin 1 under VPUA power supply system       F         30       INA2       Input       Switch input pin 2 under VPUA power supply system       F         31       INA3       Input       Switch input pin 2 under VPUA power supply system       F         31       INA3       Input       Switch input pin 3 under VPUA power supply system       F         32       INA4       Input       Switch input pin 4 under VPUA power supply system       F         33       INA5       Input       Switch input pin 5 under VPUA power supply system       F         34       INA6       Input       Switch input pin 5 under VPUA power supply system       F         34       INA6       Input       Switch input pin 7 under VPUA power supply system       F         35       INA7       Input       Switch input pin 7 under VPUA power supply system       F         36       GND       Ground       Ground        -         37       N.C.       -       No Connection        -	25		-	No Connection	
28     INA0     Input     Switch input pin 0 under VPUA power supply system (with an internal pull-up current source)     F       29     INA1     Input     Switch input pin 1 under VPUA power supply system (with an internal pull-up current source)     F       30     INA2     Input     Switch input pin 2 under VPUA power supply system (with an internal pull-up current source)     F       31     INA3     Input     Switch input pin 3 under VPUA power supply system (with an internal pull-up current source)     F       32     INA4     Input     Switch input pin 4 under VPUA power supply system (with an internal pull-up current source)     F       33     INA5     Input     Switch input pin 5 under VPUA power supply system (with an internal pull-up current source)     F       34     INA6     Input     Switch input pin 6 under VPUA power supply system (with an internal pull-up current source)     F       35     INA7     Input     Switch input pin 7 under VPUA power supply system (with an internal pull-up current source)     F       36     GND     Ground     Ground        37     N.C.     -     No Connection        38     VPUA     Input     Power supply input pin for INA and INZ switches        39     VPUA     Input     Switch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)     E<			Input		
26       INA0       Input       (with an internal pull-up current source)       F         29       INA1       Input       Switch input pin 1 under VPUA power supply system (with an internal pull-up current source)       F         30       INA2       Input       Switch input pin 2 under VPUA power supply system (with an internal pull-up current source)       F         31       INA3       Input       Switch input pin 2 under VPUA power supply system (with an internal pull-up current source)       F         32       INA4       Input       Switch input pin 4 under VPUA power supply system (with an internal pull-up current source)       F         33       INA5       Input       Switch input pin 5 under VPUA power supply system (with an internal pull-up current source)       F         34       INA6       Input       Switch input pin 5 under VPUA power supply system (with an internal pull-up current source)       F         35       INA7       Input       Switch input pin 7 under VPUA power supply system (with an internal pull-up current source)       F         36       GND       Ground       Ground       Ground          37       N.C.       -       No Connection          38       VPUA       Input       Switch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)       E <td>27</td> <td>VPUB</td> <td>Input</td> <td></td> <td></td>	27	VPUB	Input		
29       INV1       Input       (with an internal pull-up current source)       F         30       INA2       Input       Switch input pin 2 under VPUA power supply system (with an internal pull-up current source)       F         31       INA3       Input       Switch input pin 4 under VPUA power supply system (with an internal pull-up current source)       F         32       INA4       Input       Switch input pin 4 under VPUA power supply system (with an internal pull-up current source)       F         33       INA5       Input       Switch input pin 4 under VPUA power supply system (with an internal pull-up current source)       F         34       INA6       Input       Switch input pin 7 under VPUA power supply system (with an internal pull-up current source)       F         35       INA7       Input       Switch input pin 7 under VPUA power supply system (with an internal pull-up current source)       F         36       GND       Ground       Ground	28	INA0	Input		F
30INA2InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up current source)F31INA3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up current source)F32INA4InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up current source)F33INA5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up current source)F34INA6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ0InputSwitch input pin 1 onder VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 1 onder VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E45INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E <td>29</td> <td>INA1</td> <td>Input</td> <td></td> <td>F</td>	29	INA1	Input		F
31INA3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up current source)F32INA4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up current source)F33INA5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up current source)F34INA6InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin for INA and INZ switches42INZ2InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4	30	INA2	Input	Switch input pin 2 under VPUA power supply system	F
32INA4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up current source)F33INA5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up current source)F34INA6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down curren	31	INA3	Input	Switch input pin 3 under VPUA power supply system	F
33INA5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up current source)F34INA6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46 </td <td>32</td> <td>INA4</td> <td>Input</td> <td>Switch input pin 4 under VPUA power supply system</td> <td>F</td>	32	INA4	Input	Switch input pin 4 under VPUA power supply system	F
34INA6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up current source)F35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E <td>33</td> <td>INA5</td> <td>Input</td> <td>Switch input pin 5 under VPUA power supply system</td> <td>F</td>	33	INA5	Input	Switch input pin 5 under VPUA power supply system	F
35INA7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up current source)F36GNDGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E	34	INA6	Input	Switch input pin 6 under VPUA power supply system	F
36GNDGroundGroundGround37N.CNo Connection38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply systemE41INZ1InputSwitch input pin 1 under VPUA power supply systemE42INZ2InputSwitch input pin 2 under VPUA power supply systemE43INZ3InputSwitch input pin 3 under VPUA power supply systemE44INZ4InputSwitch input pin 3 under VPUA power supply systemE45INZ5InputSwitch input pin 4 under VPUA power supply systemE46INZ6InputSwitch input pin 5 under VPUA power supply systemE47INZ6InputSwitch input pin 5 under VPUA power supply systemE47INZ6InputSwitch input pin 5 under VPUA power supply systemE	35	INA7	Input	Switch input pin 7 under VPUA power supply system	F
38VPUAInputPower supply input pin for INA and INZ switches39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E	36	GND	Ground		
39VPUAInputPower supply input pin for INA and INZ switches40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E	37	N.C.	-	No Connection	
40INZ0InputSwitch input pin 0 under VPUA power supply system (with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2 under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E	38	VPUA	Input	Power supply input pin for INA and INZ switches	
40INZ0Input(with an internal pull-up/down current source)E41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E	39	VPUA	Input	Power supply input pin for INA and INZ switches	
41INZ1InputSwitch input pin 1 under VPUA power supply system (with an internal pull-up/down current source)E42INZ2InputSwitch input pin 2under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E	40	INZ0	Input		E
42INZ2InputSwitch input pin 2under VPUA power supply system (with an internal pull-up/down current source)E43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E44INZ5InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E	41	INZ1	Input	Switch input pin 1 under VPUA power supply system	E
43INZ3InputSwitch input pin 3 under VPUA power supply system (with an internal pull-up/down current source)E44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E	42	INZ2	Input	Switch input pin 2under VPUA power supply system	E
44INZ4InputSwitch input pin 4 under VPUA power supply system (with an internal pull-up/down current source)E45INZ5InputSwitch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)E46INZ6InputSwitch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)E47INZ7InputSwitch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)E	43	INZ3	Input	Switch input pin 3 under VPUA power supply system	E
45     INZ5     Input     Switch input pin 5 under VPUA power supply system (with an internal pull-up/down current source)     E       46     INZ6     Input     Switch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)     E       47     INZ7     Input     Switch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)     E	44	INZ4	Input	Switch input pin 4 under VPUA power supply system	Е
46     INZ6     Input     Switch input pin 6 under VPUA power supply system (with an internal pull-up/down current source)     E       47     INZ7     Input     Switch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)     E	45	INZ5	Input	Switch input pin 5 under VPUA power supply system	E
47 INZ7 Input Switch input pin 7 under VPUA power supply system (with an internal pull-up/down current source)	46	INZ6	Input	Switch input pin 6 under VPUA power supply system	E
48 WAKEB Output Open-drain output pin to monitor the mode of operation (Note 5) D	47	INZ7	Input	Switch input pin 7 under VPUA power supply system	E
	48	WAKEB	Output	Open-drain output pin to monitor the mode of operation (Note 5)	D

(Note 5) In the application circuit, WAKEB should be pulled-up by an external resistor.

#### **Block Diagram** VPUA VPUA VPUA VPUB AVDD AVDD 1/3/5/10/15mA(Min) Internal Oscillator VREF5 Supply AVDD INZ0 AVDD INZ7 REF5 To Logic 3/4V ا LVDD Comparator <u>}</u> AVDD 1/3/5/10/15mA(Min) Thermal Power On Shut Down Reset x8 VDDI LVDD VDDI Logic Block VPUA DMUX VPUA AVDD 1/3/5/10/15mA(Min) Τ DMUX Control WAKEB AVDD INA0 AVDD WAKEB Control INA7 To Logic M.✦M/l: 3/4V Comparator VDDI ¥ x8 INTB Control INTB VPUB Input łE VPUB **Digital Filter** AVDD 4 1/3/5/10/15mA(Min) VDDI Interval Timer AVDD (**1**)40µA INB0 AVDD INB5 Serial Interface To Logic CSB 3/4V and Comparator SCLK ₹ Registers SI x6 ≩ Ş VDDI SO TEST ᅼ GND



### Absolute Maximum Ratings

Table 3	. Pin Desc	ription	
Parameter	Symbol	Ratings	Unit
Supply Voltage Range on Pin VDDI, AVDD, LVDD Input Voltage Range on Pin CSB, SI, SCLK, TEST Output Voltage Range at Pin SO, INTB, DMUX, REF5	-	-0.3 to +7.0	V
Supply Voltage Range on Pin VPUA, VPUB Voltage Range on Pin WAKEB	-	-0.3 to +40	V
Input Current at Pin WAKEB	-	10	mA
Input Voltage on Switch Pin (INB0-INB5, INA0-INA7,INZ0-INZ7)	-	-14 to +40	V
Operating Temperature Range	T <sub>OPR</sub>	-40 to +125	°C
Storage Temperature Range	T <sub>STR</sub>	-55 to +150	°C
Maximum Junction Temperature	Tj	-40 to +150	°C

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

## Thermal Resistance (Note 6)

Table 4. Thermal Resistance

Desemptor	Cumhal	Thermal Res	istance (Typ)	L locit
Parameter	Symbol	1s (Note 8)	2s2p (Note 9)	Unit
VQFP48C				
Junction to Ambient	$\theta_{JA}$	93.7	53.3	°C/W
Junction to Top Characterization Parameter (Note 7)	$\Psi_{JT}$	4	4	°C/W

(Note 6) Based on JESD51-2A(Still-Air)
(Note 7) The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.
(Note 8) Using a PCB board based on JESD51-3 (Table 5).
(Note 9) Using a PCB board based on JESD51-5, 7 (Table 6).

Table 5, 1s

Layer Number of Measurement Board	Material	Board Size
Single	FR-4	114.3mm x 76.2mm x 1.57mmt
Тор		
Copper Pattern	Thickness	
Footprints and Traces	70µm	

		Table 6. 2s2	<u>2</u> p		
Layer Number of Measurement Board	Material	Board Size			
4 Layers	FR-4	114.3mm x 76.2mm	x 1.6mmt		
Тор		2 Internal Laye	ers	Bottom	
Copper Pattern	Thickness	Copper Pattern	Thickness	Copper Pattern	Thickness
Footprints and Traces	70µm	74.2mm x 74.2mm	35µm	74.2mm x 74.2mm	70µm

#### **Recommended Operating Conditions**

Table 7. Recommended Operating Conditions

Parameter	Symbol	Rati	ngs	Unit
	Symbol	Min	Max	Unit
Operating Temperature	T <sub>OPR</sub>	-40	+125	°C
VPUA/VPUB Supply Voltage	V <sub>VPUX</sub>	8.0	26	V
VDDI Supply Voltage	V <sub>VDDI</sub>	3.1	5.25	V
Capacitance for REF5 <sup>(Note 11)</sup>	$C_{REF}$	4.7	-	μF

(Note 10) Recommend a ceramic capacitance. Please consider variation of capacitance.

#### **Electrical Characteristics**

Spec conditions: 8.0V≤VPUA/VPUB≤26V, 3.1V≤VDDI≤5.25V, -40°C≤T<sub>OPR</sub>≤+125°C VPUA/VPUB/INZ/INA/INB terminal: resistors and capacitors are not connected REF5 terminal: 4.7µF

Unless otherwise specified, the typical condition is VPUA/VPUB=13V, VDDI=5.00V, T<sub>OPR</sub>=25°C.

Table 8. Recommended Operating Conditions
---

Parameter	Symbol/Name	Min	Тур	Max	Unit
VPUA/VPUB Supply Voltage					
VPUA/VPUB Supply Voltage Low -voltage Operating Range <sup>(Note 11)</sup>	V <sub>VPUX(QFL)</sub>	3.9	-	8.0	V
Fully Operational Voltage Range	V <sub>VPUX(FO)</sub>	8.0	-	26	v
Fully Operational Voltage Range High-voltage Operating Range <sup>(Note 12)</sup>	VVPUX(QFH)	26	-	40	
POR(Power on Reset) Activation Voltage (Note 13)	V <sub>POR(LOW)</sub>	3.9	4.2	4.5	V
POR (Power on Reset) Deactivation Voltage (Note 13)	V <sub>POR(HIGH)</sub>	4.0	4.3	4.6	V
VPUA/VPUB Operating Current					
Continuous Monitoring	I <sub>VPUX(OFF)</sub>	-	-	600	μA
Current source is invalid, "Hi-Z" Status	· · · ·				
VPUA/VPUB Average Operating Current					
Intermittent Monitoring			75	100	
Source/Sink Current Setting=1mA	I <sub>VPUX(SS)</sub>	-	75	100	μA
Monitoring Period=50ms, Strobe Time=125µs					
VDDI Operating Current	1		5	10	۵
INTB="L", CSB="H"	IVDDI	-	Э	10	μA
REF5 Output Voltage	V <sub>REF5</sub>	4.75	5.00	5.25	V

(Note 12) Electrical characteristics are not guaranteed though functions are operating. POR is active between 3.9V and 4.5V. (Note 12) Electrical characteristics are not guaranteed though functions are operating. (Note 13) The POR circuit monitors the REF5 voltage.

Table 9. Electrica	I Characteristics (Swi	tch Input)			
Parameter	Symbol/Name	Min	Тур	Max	Unit
Source Current 1 (Internal Pull-up Current Source)					
0V external supply, VPUA/VPUB system	I <sub>SOURCE1</sub>	1.0	1.4	1.8	mA
(1mA Setting)					
Sink Current 1 (Internal Pull-down Current Source)	1	1.0	1.4	1.8	~ ^
8V external supply, VPUA system (1mA Setting)	I <sub>SINK1</sub>	1.0	1.4	1.0	mA
Source Current 2 (Internal Pull-up Current Source)					
0V external supply, VPUA/VPUB system	I <sub>SOURCE3</sub>	3.0	4.2	5.4	mA
(3mA Setting)					
Sink Current 2 (Internal Pull-down Current Source)	1	2.0	4.0	<b>F</b> 4	
8V external supply, VPUA system (3mA Setting)	I <sub>SINK3</sub>	3.0	4.2	5.4	mA
Source Current 3 (Internal Pull-up Current Source)					
0V external supply, VPUA/VPUB system	ISOURCE5	5.0	7.0	9.0	mA
(5mA Setting)					
Sink Current 3 (Internal Pull-down Current Source)		5.0	7.0	0.0	
8V external supply, VPUA system (5mA Setting)	ISINK5	5.0	7.0	9.0	mA
Source Current 4 (Internal Pull-up Current Source)					
0V external supply, VPUA/VPUB system	I <sub>SOURCE10</sub>	10.0	14.0	18.0	mA
(10mA Setting)					
Sink Current 4 (Internal Pull-down Current Source)	1	10.0	11.0	10.0	
8V external supply, VPUA system (10mA Setting)	ISINK10	10.0	14.0	18.0	mA
Source Current 5 (Internal Pull-up Current Source)					
0V external supply, VPUA/VPUB system	ISOURCE15	15.0	21.0	27.0	mA
(15mA Setting)					
Sink Current 5 (Internal Pull-down Current Source)		45.0	04.0	07.0	
8V external supply, VPUA system (15mA Setting)	ISINK15	15.0	21.0	27.0	mA
Low to High Switch Detection Threshold Voltage	N/	2.7	2.0	2.2	V
(3.0V Setting)	V <sub>TH3(HIGH)</sub>	2.7	3.0	3.3	v
High to Low Switch Detection Threshold Voltage	V	2.6	2.0	2.2	N/
(3.0V Setting)	V <sub>TH3(LOW)</sub>	2.6	2.9	3.2	V
Low to High Switch Detection Threshold Voltage	N/	0.7	1.0	4.0	
(4.0V Setting)	V <sub>TH4(HIGH)</sub>	3.7	4.0	4.3	V
High to Low Switch Detection Threshold Voltage	V	2.6	2.0	4.0	V
(4.0V Setting)	V <sub>TH4(LOW)</sub>	3.6	3.9	4.2	v

Table 10. Electrical C	haracteristics (Static Electr	rical Characte	eristics)		
Parameter	Symbol/Name	Min	Тур	Max	Unit
Serial Interface Threshold Voltage (Note 14)	VINLOGIC	0.8	-	2.2	V
CSB Input Current CSB=VDDI	I <sub>CS(HIGH)</sub>	-10	-	+10	μA
CSB Pull-up Current CSB=0V	I <sub>CS(LOW)</sub>	30	-	85	μA
SI, SCLK Pull-down Resistor	R <sub>SI</sub> , R <sub>SCLK</sub>	50	100	150	kΩ
SI, SCLK Input Current SI, SCLK=0V	I <sub>SI(LOW)</sub> , I <sub>SCLK(LOW)</sub>	-10	-	+10	μA
SO "H" Level Output Voltage I <sub>SOURCE</sub> =200µA	V <sub>SC(HIGH)</sub>	V <sub>VDDI</sub> -0.8	-	V <sub>VDDI</sub>	V
SO "L" Level Output Voltage I <sub>SINK</sub> =1.6mA	V <sub>SO(LOW)</sub>	-	-	0.4	V
SO(Set to "Hi-Z") Input Current 0V to VDDI	I <sub>SO(TRI)</sub>	-10	-	+10	μA
DMUX "H" Level Output Voltage Isource=200µA	V <sub>DMUX</sub> (HIGH)	V <sub>VDDI</sub> -0.8	-	V <sub>VDDI</sub>	V
DMUX "L" Level Output Voltage	V <sub>DMUX(LOW)</sub>	-	-	0.4	V
INTB Internal Pull-up Current (Note 15)	I <sub>INTB(PU)</sub>	15	53	85	μA
INTB "H" Level Output Voltage INTB=OPEN	V <sub>INTB</sub> (HIGH)	V <sub>VDDI</sub> -0.5	-	V <sub>VDDI</sub>	V
INTB "L" Level Output Voltage I <sub>SINK</sub> =1.0mA	V <sub>INTB(LOW)</sub>	-	0.2	0.4	V
WAKEB "L" Level Output Voltage WAKEB=1.0mA	V <sub>WAKEB(LOW)</sub>	-	0.2	0.4	V
WAKEB (Set to "Hi-Z") Input Current 0V to VPUB	Iwakeb(tri)	-10	-	+10	μΑ

(Note 14) Applicable to SCLK, SI, CSB (Note 15) VDDI= 5.0V

Parameter	Symbol/Name	Min	Тур	Max	Unit
Wetting Current Timer	t	13		22	me
Counting starts after n-times detection of matched LPF	t <sub>wct</sub>	13	-	22	ms
Interrupt Delay Time1					
Time from switch status change to INTB output change	t <sub>INTB_DLY1</sub>	-	-	1	ms
in continuous monitoring					
Interrupt Delay Time 2				[Monitor	
Time from switch status change to INTB output change	t <sub>INTB DLY2</sub>	_	-	cycle] x	ms
in intermittent monitoring	INTB_DLT2			n+1	mo
n: Setting time of LPF matched n times					
Interrupt Clear Time	t <sub>INTB</sub> CLR	-	-	150	μs
Time from CSB rising edge to INTB output change	UNTB_CER			100	μο
Command Set Time	t <sub>REG EN</sub>	-	-	150	μs
Time from CSB rising edge to setting of register	KEG_EN			100	μο
Transition Time to Normal Mode	twakeb dly1	-	-	1	ms
Time from CSB rising edge to WAKEB output change	WARED_DETT				ine
Transition Time to Sleep Mode	twakeb dly2	-	-	1	ms
Time from CSB rising edge to WAKEB output change	WARED_DLT2			-	mo
Switch Strobe Time (93.75µs Setting) (Note 16)	t <sub>SCAN_94</sub>	84.375	93.75	103.125	μs
Switch Strobe Time (125µs Setting) (Note 16)	t <sub>SCAN_125</sub>	112.5	125	137.5	μs
Switch Strobe Time (187.5µs Setting) (Note 16)	t <sub>SCAN_188</sub>	168.75	187.5	206.25	μs
Switch Strobe Time (250µs Setting)	t <sub>SCAN_250</sub>	225	250	275	μs
Source/Sink Current Rise Time					
FSQ="0", FSQZ/A/B="0", 10mA Setting	t <sub>SR_R</sub>	-	20	-	μs
Load Resistance 100Ω					
Source/Sink Current Fall Time					
FSQ="0", FSQZ/A/B="0", 10mA Setting	t <sub>SR_F</sub>	-	15	-	μs
Load Resistance 100Ω					
Internal Clock Accuracy	t <sub>TIMER</sub>	-10	-	+10	%

Table 11. Electrical Characteristics (Dynamic Electrical Characteristics)

(Note 16) "H" width of internal signal (Ref. Page 12 Figure 6).

Parameter	Symbol/Name	Min	Тур	Max	Unit
SCLK Frequency	f <sub>SCLK</sub>	-	-	4.4	MHz
Setup Time from CSB Fall to SCLK Rise	t <sub>LEAD</sub>	100	-	1000	ns
Setup Time from SCLK Fall to CSB Rise	t <sub>LAG</sub>	50	-	500	ns
Setup Time from SI to SCLK Fall	t <sub>SI(SU)</sub>	16	-	-	ns
Hold Time from SCLK Fall to SI	t <sub>SI(HOLD)</sub>	20	-	-	ns
SI, CSB, SCLK Rise Time	t <sub>R(SI)</sub>	-	5.0	-	ns
SI, CSB, SCLK Fall Time	t <sub>F(SI)</sub>	-	5.0	-	ns
Time from CSB Fall to SO Output Low Impedance	t <sub>SO(EN)</sub>	-	-	55	ns
Time from CSB Rising to SO Output High Impedance	t <sub>SO(DIS)</sub>	-	-	55	ns
SCLK "H" Level Width	t <sub>SCLKH</sub>	75	-	-	ns
SCLK "L" Level Width	t <sub>SCLKL</sub>	75	-	-	ns
Time from SCLK Rise to Stable SO Data Output SO CL=20pF	t <sub>VALID</sub>	-	25	55	ns
CSB "H" Level Time	t <sub>CSBH</sub>	150	-	-	μs

#### Table 12. Electrical Characteristics (Digital Interface Characteristics)

#### **Timing Chart**

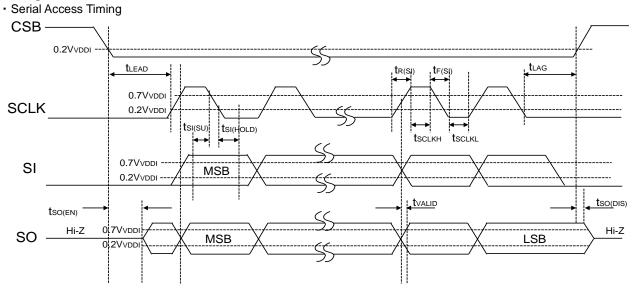


Figure 4. Serial Access Timing

#### BD3375KV-C

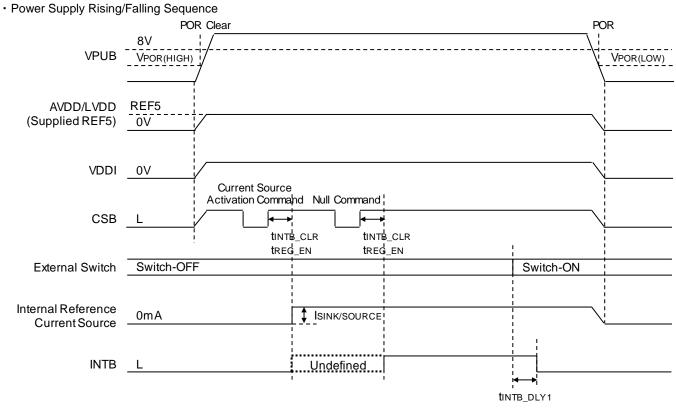


Figure 5. Power Supply Rising/Falling Sequence

#### Source/Sink Current Rise and Fall Time

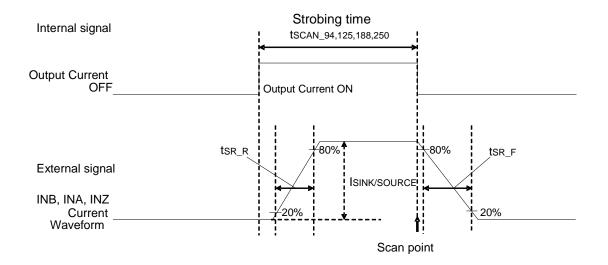
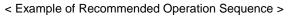


Figure 6. Intermittent Monitoring Enabled (FSQ=0, FSQZ/A/B=0, CMB/A/Z=1), Source/Sink Current Rise and Fall Time

#### [Basic Operation 1] Detection of Switch Status Change (Continuous Monitoring)

Upon detection of a change in switch status, interrupt (INTB="H" $\rightarrow$ "L") occurs and the IC requests serial communication with the MCU.



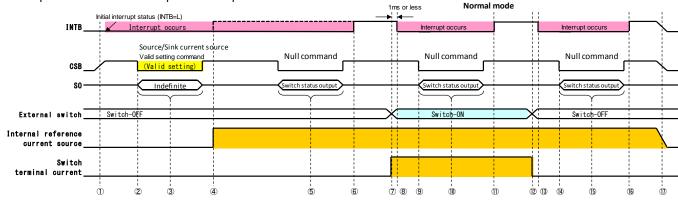


Figure 7. Basic Operation 1

①After power is turned on, interrupt (INTB="L") occurs.

②By serial communication, the switch status is obtained by the MCU at CSB falling edge.

3 Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined.

(4) Internal reference current source is activated

SSwitch status is output by SO.

**(b**Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change. The switch change occurs (OFF $\rightarrow$ ON) and IC detects switch status change.

 $(INTB="H" \rightarrow "L")$  is notified to MCU, and serial communication is requested

(9) By serial communication, switch status is obtained by the MCU at CSB falling edge.
 (10) Switch status is output by SO.

Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change. Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change.

(INTB="H" $\rightarrow$ "L") is notified to MCU, and serial communication is requested

By serial communication, the switch status is obtained by the MCU at CSB falling edge.Switch status is output by SO.

(f)Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change. (f)Power is turned off.

#### [Basic Operation 2] Detection of Switch Status Change (Intermittent Monitoring)

When Intermittent Monitoring is enabled, switch status is monitored by periodically turning the current source on and off. Intermittent monitoring allows low power consumption.

< Example of Recommended Operation Sequence >

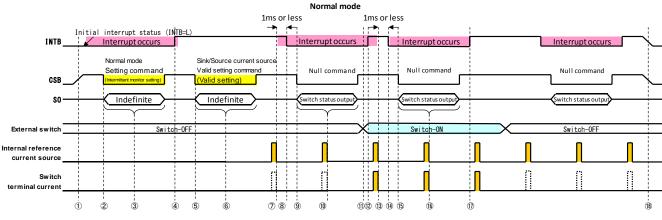


Figure 8. Basic Operation 2

①After power is turned on, interrupt (INTB="L") occurs.

2 By serial communication, the switch status is obtained by the MCU at CSB falling edge.

③Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined.

(4) Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change.

(5)By serial communication, switch status is obtained by the MCU at CSB falling edge.

O Since the current source is OFF, the switch terminal is "Hi-Z", and the output of SO is undefined. O IC gets the switch status when the current source is ON.

(BInterrupt (INTB="H" $\rightarrow$ "L") is notified to MCU, and serial communication is requested

(9)By serial communication, switch status is obtained by the MCU at CSB falling edge.

Switch status is output by SO.

①IC detects switch status change.

(Dinterrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change. (Directs switch status change.

M Interrupt (INTB="H" $\rightarrow$ "L") is notified to MCU, and serial communication is requested

(15)By serial communication, switch status is obtained by the MCU at CSB falling edge. (16)Switch status is output by SO.

(1) Interrupt is cleared (INTB="L" $\rightarrow$  "H") by CSB rising edge and prepares for switch change. (1) Power is turned off.

#### [Basic Operation 3] Sleep Mode Operation (Manual Transition)

When MDC register of Monitor Mode Transition Command is set to "1", mode is changed to sleep. When MDC register of Monitor Mode Transition Command is set to "0", mode is changed to normal. During sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up.

< Example of Recommended Operation Sequence >

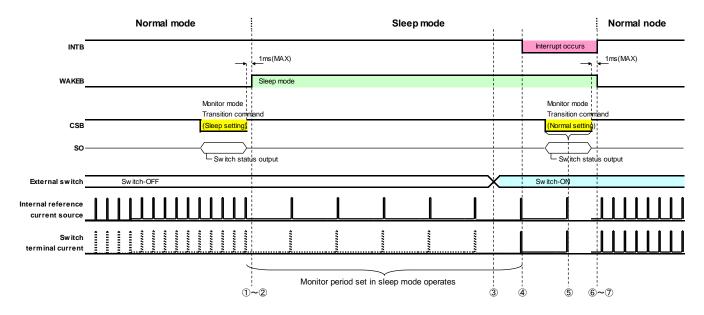


Figure 9. Basic Operation 3

①Monitor mode transition command (Sleep mode setting) is received from MCU.

②Transition to sleep mode.

③Switch change occurs (OFF $\rightarrow$ ON).

④IC detects switch status change.

(5)IC informs MCU the interrupt (INTB="H" $\rightarrow$ "L") and switch status is output by SO.

6 Monitor mode transition command (Normal mode setting) is received from MCU.

 $\bigcirc$  Transition to normal mode.

#### [Basic Operation 4] Sleep Mode Operation (Automatic Transition to Normal Mode)

Automatic transition from sleep mode to normal mode when a switch status changes is possible when the automatic mode transition setting is enabled.

During sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up.

< Example of Recommended Operation Sequence >

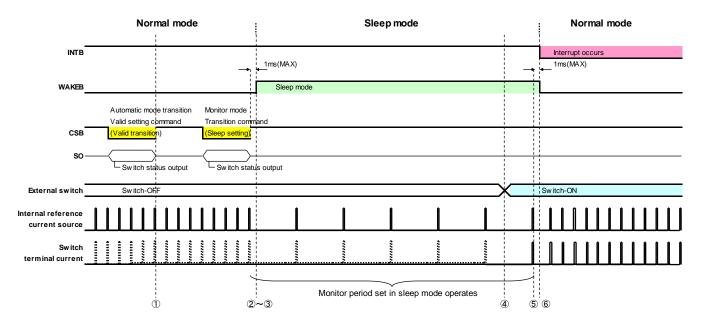


Figure 10. Basic Operation 4

①Automatic transition of mode is enable.

②Monitor mode transition command (sleep mode setting) is received from MCU.

③Transition to sleep mode.

④Switch change occurs (OFF $\rightarrow$ ON).

⑤IC detects switch status change.

(6)IC informs the interruption to MCU with INTB("H"  $\rightarrow$  "L") and changes to Normal mode automatically.

#### **Description of Functions**

1. Power on Reset (POR)

Upon the application of an external voltage to VPUB, REF5 output is generated by the LDO inside the IC. When REF5  $\leq$  4.2(Typ), POR is activated. When REF5  $\geq$  4.3(Typ), POR is deactivated.

2. Serial Interface

Communication between BD3375KV-C and the MCU uses terminals chip select bar input (CSB), serial clock input (SCLK), serial data input (SI), and serial data output (SO).

CSB is internally pulled-up to VDDI. When CSB status is "0", SCLK and SI inputs are valid, and it is possible to read data from SO. When CSB status is "1", SCLK and SI inputs are invalid, and SO status is "Hi-Z".

Communication Frame

The transmitted frame by the MCU is a 40-bit structure composed of the transmission and reception discrimination (2-bit), the address (6-bit), the data (24-bit), and the CRC (8-bit). The transmission and reception discrimination (2-bit) is intended to differentiate between the transmitted and the received frame. The command (6-bit) sets various settings such as the "valid interrupt setting command". The CRC (8-bit) outputs the result of a 39 to 8 bit CRC calculation. If a CRC error occurs, either when the structure of the frame is not 40-bit or when the transmission and reception discrimination bit is an error (the 33-bit of the SO frame is "H"), communication error is output and data is not recognized. As for writing, SI data is latched by internal shift register at timing of SCLK falling.

			Ta	able 1	3. Se	erial D	Data I	nput	(SI)								
Communication frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
SI input bit	35         36         37         36         34         35         32         31         30         29         20         21         20         23         24           Register address																
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
								Setting	g data								CRC

The received frame by the MCU has two types of bit alignment, "switch status output" and "register value output".

The switch status output bit alignment is a 40-bit structure composed of transmission and reception discrimination (2-bit), a fixed value (1-bit), interrupt factor output (5-bit), another fixed value (1-bit), mode status output (1-bit), switch status output (22-bit), and CRC (8-bit).

Transmission and reception discrimination (2-bit) is intended to discriminate transmit and receive frame. The interrupt factor is discussed on Page 19. When an interrupt factor occurs, the corresponding bit becomes "1". Mode status (1-bit) is "0" when set to normal mode, and it is "1" when set to sleep mode. Switch status output (22-bit) is "1" when external switch is ON, and it is "0" when external switch is OFF. The CRC (8-bit) outputs the result of a 39 to 8 bit CRC calculation.

The switch status is latched to the timing of CSB falling edge. The then in order of interrupt factor output, mode status and switch status output are output from SO by SCLK rising.

Table 14.	Serial	Data	Outp	out (	SO-S	Switch	Stat	us O	utput)	

Output frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
SO output bit	1	0	0		Interrup	ot facto	r output	t	0	Mode		Switch	INB5-0	status	output		
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
			Switch	INA7-0	) status	output					Switch	INZ7-0	status	output			CRC

The register value output bit alignment is a 40-bit structure composed of transmission and reception discrimination (2-bit), a fixed value (1-bit), interrupt factor output (5-bit), register value output (24-bit), and CRC (8-bit).

The data is output by SO at SCLK's rising edge after the CSB falling edge of the command following the register value output command.

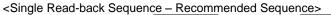
The bit alignment of the register value output is shown on Table 37. The sequence of register value output is shown in Figure 11 and Figure 12.

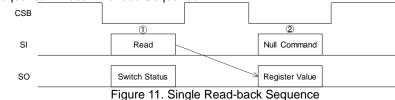
#### Table 15. Serial Data Output (SO-Register Value Output)

	Table	e 15.	Sella	a Dai	a Ou	ւքսւ (	<u>30-r</u>	egist	er va	lue C	ulpul	.)					_
Output frame	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
SO output bit	1	0	0		Interrup	ot facto	r output				Re	gister va	alue ou	itput			
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
				•	•		Rec	ister va	alue ou	tput			•	•	•		CRC

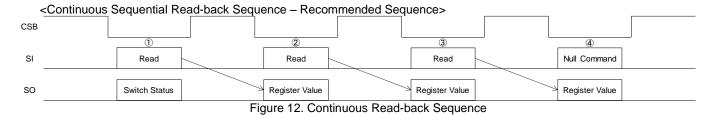
The register value output command (Table 38 RIER to RMDR) is used to read-back the register value written by register write command (Table 37 IER to MDR).

Figure 11 describes the single read-back sequence. Figure 12 describes the continuous read-back sequence.





- ① Send the register value output command.
- The switch status is output by SO.
- ② Read the register value by sending the Null command. The result of the register value output command ① is output by SO.



- ① Send the register value output command.
- The switch status is output by SO.
- 2 Send the register value output command following ①. (The address of the register value output command does not need to be the next address.)
- ③ Send the register value output command repeatedly as needed.
- The SO output at each command is the result of the previous register value output command.
- Send the Null command in the end. The register value of the previous register output command is output by SO.
- 3. Switch Status Output

Switch status can be sent through SO output.

#### 4. Interrupt (INTB operation)

There are five interrupt factors that cause the INTB terminal to output an "L". The type of interrupt factor that occurred can be checked in the SO output when CSB is "L".

INTB output will return to "H" once the interrupt factor is cleared by the rising edge of CSB. The INTB terminal is an open-drain output that is internally pulled-up to VDDI.

#### Interrupt Factors

The interrupt factors are shown below:

Interrupt Factor	Interrupt flag (SO output)	Flag name
① Test detection	SO output bit [36]	: "test_flg"
② Thermal shutdown detection	SO output bit [35]	: "them_flg"
③ Reset detection	SO output bit [34]	: "rst_flg"
④ Communication error detection	SO output bit [33]	: "err_flg"
(CRC error, 40-bit frame error, or transmission and rece	ption discrimination error)	
5 Switch status change detection	SO output bit [32]	: "sw_flg"

#### ① Test detection

The IC generates an interrupt after a transition to test mode. The TEST terminal should always be connected to ground.

2 Thermal shutdown detection

Interrupt occurs when the thermal shutdown circuit detects a temperature higher than the allowable junction temperature inside IC.

③ Reset detection

Interrupt occurs after the activation of Power on Reset (POR) or the transmission of the reset command. Upon POR activation, the SO output interrupt flag "rst\_flg" is reflected instantly. With reset command transmission, "rst\_flg" is reflected on the next command transmission.

(4) Communication error detection

Interrupt occurs due to either a CRC error, a 40-bit frame error, or a command transmission error. The interrupt flag "err\_flg" is triggered by the following:

CRC error : when there is a Cyclic Redundancy Check error 40-bit frame error : when the command received is not 40-bit Transmit and receive determination error : when the first two bits of the command received is not [39:38]="01"

5 Switch status change detection

Interrupt occurs when switch a status changes (switch-ON→OFF or switch-OFF→ON).

· Clearing of INTB output and interrupt factor

The INTB "L" output and the interrupt factor are both cleared by the CSB rising edge during command transmission. In case a new interrupt factor occurs during command transmission, the interrupt factor is not cleared. The new interrupt factor is reflected on the next command transmission.

The interrupt factor is not cleared by the register readout that follows the register value output command.

#### 5. Operating Modes

BD3375KV-C has two types of operating mode, the normal and the sleep mode. Transition between the two modes can be done by sending the correct "Monitor Mode Transition Command". The current mode of operation can be checked through the WAKEB and the SO terminal outputs.

Monitor Mode Transition register address (0x4F): Bit [31]: 0=Normal mode, 1=Sleep mode)

Normal Mode

Normal mode operation can be set to continuous monitoring, wherein the switch status is checked by a continuously ON current source, or to intermittent monitoring, wherein the switch status is checked by a regularly ON/OFF current source. The period of intermittent monitoring <sup>(Note 17)</sup> can be set according to power supply system while strobe time <sup>(Note 18)</sup> is common for all switch terminals.

At normal mode, WAKEB is "L" and the 30-bit of the SO output is "0".

Sleep Mode

Sleep mode operation, like in normal mode, can be set to continuous monitoring or intermittent monitoring. The monitoring period <sup>(Note 17)</sup> of intermittent monitoring can be set according to power supply system. The strobe time <sup>(Note 18)</sup> is common for all switch terminals and both modes.

The difference with normal mode is that, from sleep mode, it is possible to change to normal mode automatically when interrupt occurs. (Automatic mode transition function)

At sleep mode, WAKEB is in "Hi-Z" state and its voltage level is the level of the external pull-up. The 30-bit of SO output is "1" at sleep mode.

(Note 17) Monitor period (Note 18) Strobe time

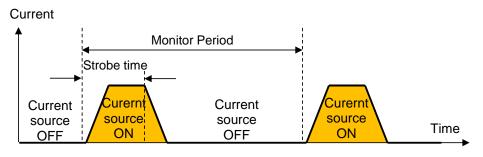


Figure 13. Intermittent Monitoring

6. Automatic Mode Transition Function

By sending the "Automatic Mode Transition Command" through setting the MIR register (0x4E) to "1", automatic transition from sleep to normal mode is possible. The conditions for a change in mode from sleep to normal to occur for both enabled and disabled "Automatic Mode Transition Function" are shown below:

· Conditions for sleep to normal mode transition when "Automatic Mode Transition Function" is enabled:

- 1. Normal mode transition command is sent
- 2. POR occurs or reset command sent (Initialization)
- 3. A switch status changes (The "Switch Change Interrupt Setting" should be enabled)

• Conditions for sleep to normal mode transition when "Automatic Mode Transition Function" is disabled:

- 1. Normal mode transition command is sent
- 2. POR occurs or reset command sent (Initialization)

[Extension Function1: Intermittent Monitoring at the Same Time (with Current Slope)]

In intermittent monitoring, it is possible to detect the status of the all switches at the same time. When all inputs are set to detect the switch status by intermittent monitoring, the wetting current has a rising and falling slope.

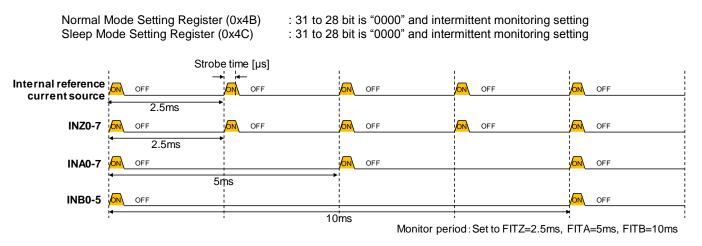
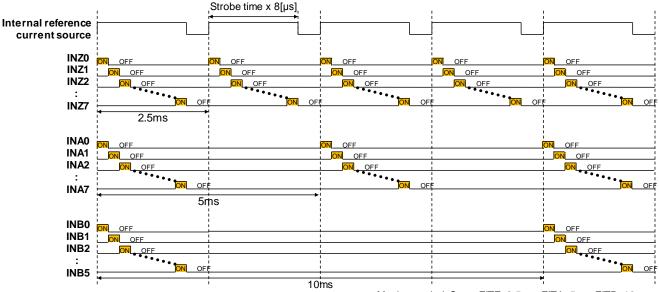


Figure 14. Intermittent Monitoring at the Same Time Example

[Extension Function 2: Sequential Monitoring by Power Supply System]

In this type of sequential monitoring, the status of the switches within a power supply system is monitored one at a time. This type has no slope. Since no two or more current sources in a power supply system are ON at the same time, radiation noise is reduced.



Monitor period: Set to FITZ=2.5ms, FITA=5ms, FITB=10ms

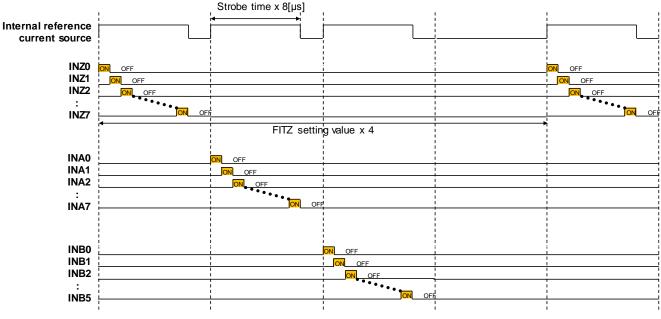
Figure 15. Sequential Monitoring by Power Supply System Example

[Extension Function 3: Sequential Monitoring of All Switch Terminals]

In this type of sequential monitoring, the status of all switches is monitored one at a time.

Since no two or more current sources are ON at the same time, radiation noise is reduced. This type has no slope.

The monitoring period for all switches increases by four times the monitoring period set for the INZ channels as shown in Figure 16. Uniform sequential monitoring and sequential monitoring by power supply should not be enabled at the same time. In case the two sequential monitoring methods are activated simultaneously, the method which prevails is uniform sequential monitoring.



Monitor period: Set to FITZ=2.5ms, FITA=5ms, FITB=10ms

Figure 16. Sequential Monitoring of All Switches Terminals Example

7. WAKEB Terminal

WAKEB is an open drain output pin. In normal mode, its output is "L". In sleep mode, its output is "Hi-Z" and its voltage level is the level of the external pull-up.

8. Source/Sink Current Source for Switch Terminal

There are three types of switch terminal inputs with internal current source: INZ, INA, and INB. The current level can be set for each switch terminal.

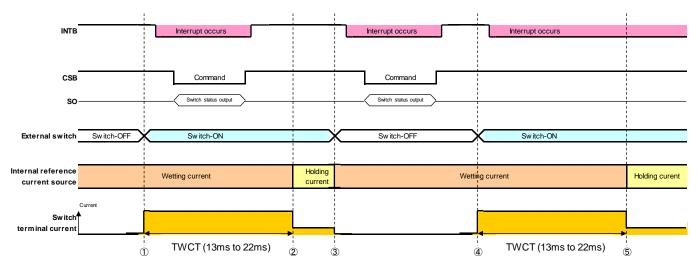
- Current Source of INZ system (INZ0 INZ7)
   This current source is used to source or sink current to the external switch. The wetting current can be interchanged between pull-up and pull-down. VPUA is the power supply for the pull-up current source.
- Current Source of INA (INA0 INA7)
   This current source is used to source current to the external switch. VPUA is the power supply
- Current Source of INB (INB0 INB5)
   This current source is used to source current to the external switch. VPUB is the power supply.

The current source settings can be fixed by INZ current source/sink selection command, the current source setting command, and the holding current/wetting current value setting command.

#### 9. Wetting Current Timer

The wetting current timer is 13ms to 22ms. This function can be enabled individually for each switch terminal. The timer starts after the switch has been detected as ON. After the 13ms to 22ms timer is finished, the wetting current (10mA/15mA) is switched to holding current (1mA/3mA/5mA). The timer is reset after the switch is turned OFF.

[Function operation1] Wetting Current Timer (Continuous Operation)



#### Figure 17. Wetting Current Timer (Continuous Operation)

- ① Switch change occurs (OFF $\rightarrow$ ON), IC detects switch status change.
- 2 When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.
- (3) Switch change occurs (ON $\rightarrow$ OFF).
- (4) Switch change occurs (OFF $\rightarrow$ ON), IC detects switch status change.
- 5 When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.

#### [Function operation2] Wetting Current Timer (Intermittent Monitoring)

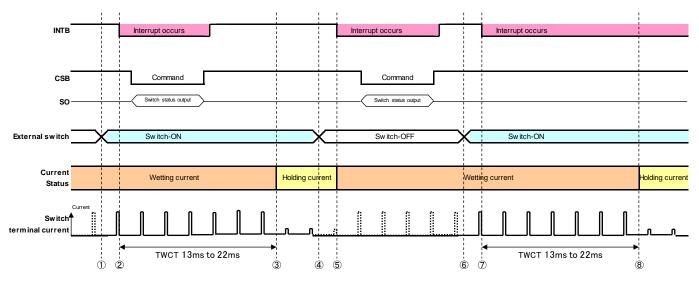


Figure 18. Wetting Current Timer (Intermittent Monitoring)

- (1) Switch change occurs (OFF $\rightarrow$ ON)
- 2 IC detects switch status change.
- ③ When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.
- ④ Switch change occurs ( $ON \rightarrow OFF$ ).
- 5 IC detects switch status change, switch current is switched from holding current to wetting current.
- 6 Switch change occurs (OFF $\rightarrow$ ON).
- $\bigcirc$  IC detects switch status change.
- ⑧ When ON state of the switch continues for more than 13ms to 22ms, the holding current is output.

#### BD3375KV-C

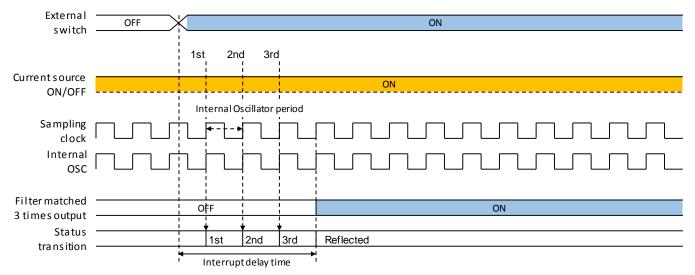
#### 10. n-Times Matched Filter

All switch inputs have built-in "1 to 6 times matched filters". This function can filter the ON/OFF switch status judgment made by the internal comparator. The filter function can be enabled for each power supply system. If the register has been updated during the counting of the filter, the counting is not reset.

If the monitoring method is continuous monitoring, the switch state is filtered n times (n: 1 to 6) multiplied by the period of the internal oscillator (32 kHz).

If the monitoring method is intermittent monitoring, the switch state is filtered n times (n: 1 to 6) multiplied by the monitoring period.

• Set to full-time monitor : Sampling period is internal oscillator period : 31.25µs (Typ)



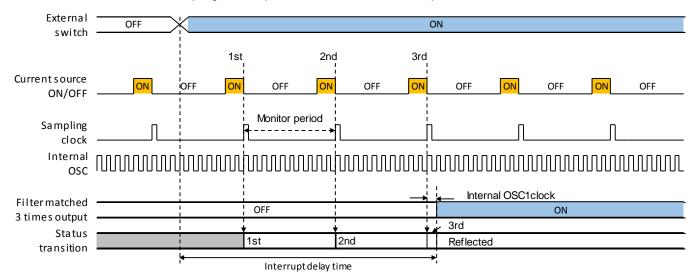
Time from Monitoring to End of Filtering:

{Monitoring Period x (Filter Number of Times -1) + Period of Internal Oscillator}

to {Monitoring Period x (Filter Number of Times) + Period of Internal Oscillator}

Figure 19. 3 Times Matched Filter Operation on Continuous Monitoring

• Set to intermittent monitor : Sampling monitor period is common with monitor period.



Time from Monitoring to End of Filtering:

{Monitoring Period x (Filter Number of Times -1) + Period of Internal Oscillator} to {Monitoring Period x (Filter Number of Times) + Period of Internal Oscillator}

Figure 20. 3 Times Matched Filter Operation on Intermittent Monitoring

#### 11. Digital Multiplexer Output (DMUX)

The status of the selected switch input is reflected by the DMUX terminal. DMUX takes the output of the comparator on a timing determined by the monitoring method. Only one switch terminal at a time can be selected to be reflected by DMUX.

When no switch is selected, the output of DMUX is "L".

12. Input Threshold Voltage of Switch Terminal

The switch input threshold voltage is a fraction of the AVDD voltage. It can be set to 3.0V or to 4.0V.

- 3.0V Setting : V<sub>TH3</sub>=AVDDx0.6 (8.0V≤VPUB≤26V)
- 4.0V Setting :  $V_{TH4}$ =AVDDx0.8 (8.0V≤VPUB≤26V)

Table 16. Relationship between the Switch Input Threshold Voltage and the SO Output

Input type	Source or Sink	Input Voltage	Comparator output	SO serial interface bit
	Source	INZ <threshold< td=""><td>0</td><td>Н</td></threshold<>	0	Н
INZ	Source	INZ>Threshold	1	L
IINZ	Sink	INZ <threshold< td=""><td>0</td><td>L</td></threshold<>	0	L
	Sink	INZ>Threshold	1	Н
	N/A	INA,INB <threshold< td=""><td>0</td><td>Н</td></threshold<>	0	Н
INA,INB	N/A	INA,INB>Threshold	1	L

#### 13. Over-temperature Protection Circuit

When the junction temperature of the IC becomes higher than the thermal limit 160°C (Typ), interrupt (INTB="L") occurs and the source/sink current through the switch terminals is switched to 1mA (Min). The MCU is notified by the SO over-temperature detection flag (them\_flg) changing to "1" that an irregularity in temperature has occurred. When the junction temperature of the IC has fallen below 140°C (Typ), interrupt is cleared on the next command transmission and the wetting current level returns to what was set on the registers.

Notice: The over-temperature detection value, 155°C to 175°C, and the hysteresis temperature, 10°C to 30°C, were not tested in shipment test. Also, the over-temperature protection circuit operates beyond the absolute maximum temperature ratings so the IC should not be used in a system where activation of the said protection function is expected.

#### 14. Cyclic Redundancy Check (CRC)

The 7-0<sup>th</sup> bit of both the transmitted and received communication frame of the IC is the cyclic redundancy check (CRC), which is responsible for the detection of a data communication error.

If the IC received a CRC error, asserts interruption (INTB="L") and error flag ("err\_flg") to SO output. SO output becomes "H" on the next communication to notify the MCU of the error. A command that has a CRC error is not a valid command.

The CRC generation polynomial is  $X^8 + X^5 + X^4 + 1$ .

#### **Command Description**

Each Command has two types of functions. One is to write a value to a register. The other is to read back the register value which was written by the write command. The function to be used is set by the 37-bit of each command. (The Null and Reset commands don't include the register value output command because they don't write in the registers.)

In the command descriptions below, the Write Command is for writing a value to a register and the read command is for reading back a register value.

#### 1. Null Command

This command is a read only command that allows the user to monitor interruption and switch status.

					Table	e 17. l	Null (	Comm	nand									
Command				R	egister	addres	s						Settin	g data				
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Null Command (Read Only)	IRC	0	1	0	0	0	0	0	0	х	х	х	х	х	х	х	х	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC

2. Interrupt Notification of Switch Change Setting Command

This command allows the user to configure interrupt sources for the INTB pin.

Specifically, this command allows the user to individually configure which switches trigger an interrupt on INTB by enabling or disabling the IEBn, IEAn, and IEZn setting bits shown below.

The SO output will return the switch status depending on the settings stored at the next CSB falling edge.

#### Table 18. Interrupt Notification of Switch Change Setting Command

Command			R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Interrupt Notification of Switch Change Setting IER	0	1	W/R	0	0	0	0	1	х	х	IEB5	IEB4	IEB3	IEB2	IEB1	IEB0	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	IEA7	IEA6	IEA5	IEA4	IEA3	IEA2	IEA1	IEA0	IEZ7	IEZ6	IEZ5	IEZ4	IEZ3	IEZ2	IEZ1	IEZ0	CRC
IEBn (n: 5-0) [Default: 1]			rrupt )isabl		icatio	n of S 1:	Switch Enab		us Cl	hange	e for I	NB S	Syster	n			
IEAn (n: 7-0) [Default: 1]			rrupt Disabl		icatio	n of S 1:	Switch Enab		tus Cl	hange	e for l	NA S	Syster	n			
IEZn (n: 7-0) [Default: 1]			rrupt Disabl		icatio	n of S 1:	Switch Enab		tus Cl	hange	e for l	NZ S	Syster	n			
W/R			gister Vrite	Write	e/Rea	d Set 1:	ting Read										

3. Comparator Operation Control Command

This command allows the user to individually enable or disable the switch terminal comparator for each switch input. When a switch input's comparator is disabled through this register, both the corresponding settings available for that switch input within the "Interrupt Notification of Switch Change Setting Command" and the "Source/Sink Current Setting Command" are invalid.

When the comparator is active, the switch status output does not depend on whether the wetting current is set to source or sink. The switch status output is "1" when the switch is ON and "0" when the switch is OFF. When the comparator is set to disabled, the switch status is undefined.

	Table	e 19. (	Comp	arato	or Op	eratic	n Co	ntrol	Comr	nand							
Command			R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Comparator Operation Control CMR	0	1	W/R	0	0	0	1	0	х	х	CMB5	CMB4	CMB3	CMB2	CMB1	CMB0	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	CMA7	CMA6	CMA5	CMA4	CMA3	CMA2	CMA1	CMA0	CMZ7	CMZ6	CMZ5	CMZ4	CMZ3	CMZ2	CMZ1	CMZ0	CRC
CMBn (n: 5-0) [Default: 1] CMAn (n: 7-0) [Default: 1] CMZn (n: 7-0) [Default: 1] W/R	0: Co 0: Co 0: Re	mpar Disab mpar Disab mpar Disab gister Write	led ator C led ator C led	Dpera Dpera	1: ation f 1: ation f 1: ad Se	Enat or IN Enat or IN Enat	oled A Sys oled Z Sys ole	stem									

T-1-1- 40 0 -----

#### 4. Comparator Threshold Selection Command

This command allows the user to set the comparator threshold of the switch terminals.

Switch detection threshold selection is available for each power supply system (See CTB, CTA, CTZ settings shown below).

					0			00.0	00.0	0		mane	A					
Command				R	egister	addre	SS						Settin	g data				
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Comparator Threshold Selection	CTR	0	1	W/R	0	0	0	1	1	СТВ	CTA	CTZ	х	х	х	х	х	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
CTB [Default: 0]			Cor	npara	ator T	hrest	hold f	or IN	3 Sys	stem	-		-	-	-			
			0: 3	.0V			1:	4.0V	-									
CTA [Default: 0]			Cor	npara	ator T	hrest	nold f	or IN	A Sys	tem								
			0: 3	.0V			1:	4.0V										
CTZ [Default: 0]			Cor	npara	ator T	hrest	nold f	or IN	Z Sys	tem								
			0: 3	.0V			1:	4.0V										
W/R			Reg	gister	Write	e/Rea	d Set	tting										
			0: V	Vrite			1:	Read										

#### Table 20. Comparator Threshold Selection Command

5. INZ Current Source/Sink Selection Command

This command allows the user to select the current configuration, whether source (internal pull-up current source) or sink (internal pull-down current source), through the INZ input switch terminals.

		Ia	ole 2	1. INZ		rent S	sourc	e/Sin	k Sel	ectior	n Con	nman	d					
Command				R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
INZ Current Source/Sink Selection	PUDR	0	1	W/R	0	0	1	0	0	х	х	х	х	х	х	х	х	
	[								Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	PUD7	PUD6	PUD5	PUD4	PUD3	PUD2	PUD1	PUD0	CRC
PUDn (n: 7-0) [Defa	ult: 0]		Sou	irce o	or Sin	k Sel	ectior	n for I	NZ S	ysten	n							
			0: S	Source	e (Int	ernal	Pull-	up Cu	irrent	Sour	rce)							
			1: S	Sink (I	ntern	al Pu	ll-dov	wn Cu	urrent	Sou	rce)							
W/R			Reg	gister	Write	e/Rea	d Set	tting										
			0: V	Vrite			1:	Read										

### Table 21 INZ Current Source/Sink Selection Command

6. Current Source Activation Command

This command allows the user to enable or disable the wetting current sources at the switch input terminals. The current sources can be set to ON or OFF per power supply system.

The output current level is determined by the "Holding Current / Wetting Current Value Setting Command" discussed in section 7 below.

If an external current source is used, the comparator should be enabled (see section 3 above) and the internal current source should be disabled using this register.

			Tabl	e 22.	Curre	ent S	ource	e Activ	/atior	Corr	man	d						
Command				R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Current Source Activation	CER	0	1	W/R	0	0	1	0	1	CEB	CEA	CEZ	х	х	х	х	х	
									Settin	g data								CRC
		23													8	7-0		
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
CEB [Default: 0]			Cur 0: C		Sourc	es of		Syste ON	em									
CEA [Default: 0]			Cur 0: C		Sourc	es of		Syste ON	em									
CEZ [Default: 0]			Cur 0: C		sourc	e of I		ysten ON	ſ									
W/R				gister Vrite	Write	e/Rea		tting Read										

**T** 1 1 00 0 . . 

#### 7. Holding Current / Wetting Current Level Selection Command

This command allows the user to select the output level of each current source. This command also has arguments to set both the holding and the wetting current.

The holding current can be set to 1mA, 3mA, or 5mA.

The wetting current can be set to OFF ("Hi-Z"), 1mA, 3mA, 5mA (set to holding current), 10mA, or 15mA. Unlike holding current, wetting current output levels can be set individually for each switch terminal.

#### Table 23. Holding Current / Wetting Current Level Selection Command (LSB)

Command				R	egister	addres	s						Settin	g data				
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Holding Current / Wetting Current Level Selection (LSB)	LCR	0	1	W/R	0	0	1	1	0	CRH1	CRH0	LCB5	LCB4	LCB3	LCB2	LCB1	LCB0	
	ĺ								Settin	g data								CRC
		00				40	4.0	47	4.0	4.5		10	40		10	0	•	7.0
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0

#### Table 24. Holding Current / Wetting Current Level Selection Command (MSB)

Command				R	egister	addres	s						Settin	g data			
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24
Holding Current / Wetting Current Level Selection (MSB)	MCR	0	1	W/R	0	0	1	1	1	х	х	MCB5	MCB4	MCB3	MCB2	MCB1	MCB0

							Settin	g data								CRC
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
MCA	7 MCA6	MCA5	MCA4	MCA3	MCA2	MCA1	MCA0	MCZ7	MCZ6	MCZ5	MCZ4	MCZ3	MCZ2	MCZ1	MCZ0	CRC

CRH [1:0]	[Default: 00]	Holding Current Value	
		00: 1mA	01: 3mA
		10: 5mA	11: 1mA
{MCBn (n: 5-0), LCBn (n: 5-0)}	[Default: 01]	Wetting Current Value for	or INB System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
{MCAn (n: 7-0), LCAn (n: 7-0)}	[Default: 01]	Wetting Current Value for	or INA System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
{MCZn (n: 7-0), LCZn (n: 7-0)}	[Default: 01]	Wetting Current Value for	or INZ System
		00: Invalid(Hi-Z)	01: 1/3/5mA(Holding Current Value)
		10: 10mA	11: 15mA
W/R	Register Write	Read Setting	
	0: Write	1: Read	

#### 8. Wetting Current Operation Control Command

This command allows the user to enable or disable the "wetting current timer".

\_ . .

This "wetting current timer" counts 13 to 22ms after the switch has been closed and the wetting current changes to holding current (1mA/3mA/5mA). The timer is reset when the switch is turned off.

If the wetting current level is the same as the holding current level, the timer does not operate.

The wetting current timer can be enabled or disabled individually for each switch terminal.

_			Tab	le 25	. Wet	ting C	Currer	nt Op	eratio	on Co	ntrol	Com	mand						
	Command				R	egister	addres	ss						Settin	g data				
	0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
	Wetting Current Operation Control	WTR	0	1	1 W/R 0 1 0 0 0 x x WTB5 WTB4 WTB3 WTB2 WTB1 WTB0														
										Settin	g data								CRC
			23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
			WTA7	WTA6	WTA5	WTA4	WTA3	WTA2	WTA1	WTA0	WTZ7	WTZ6	WTZ5	WTZ4	WTZ3	WTZ2	WTZ1	WTZ0	CRC

WTBn (n: 5-0) [Default: 0]	Wetting Current Timer for INB System
	0: Disabled 1: Enabled
WTAn (n: 7-0) [Default: 0]	Wetting Current Timer for INA System
	0: Disabled 1: Enabled
WTZn (n: 7-0) [Default: 0]	Wetting Current Timer for INZ System
	0: Disabled 1: Enabled
W/R	Register Write/Read Setting
	0: Write 1: Read

#### 9. n-Times Matched Filter Activation Control Command

This command allows the user to enable or disable the n-times matched LPF.

If this function is enabled, the switch output is updated only after the comparator output has been sampled "n" times (where n = 1 to 10) and if all sampled comparator outputs match.

This command allows for each switch terminal to be enabled or disabled individually.

Command			R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x: don't care	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
n-Times Matched Filter Activation Control DFR	0	1	W/R	0	1	0	0	1	DFB2	DFB1	DFB0	DFA2	DFA1	DFA0	DFZ2	DFZ1	
								Settin	g data								CRC
	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
	DFZ0	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
DFB [2:0] [Default: 000]	[Default: 000] n-Times Matched LPF S 000 : Disabled (1 010 : 3 times 100 : 5 times 110 : Disabled (1									00	01 11 01	: •	2 time 4 time 6 time Disat	es es	1 time	e)	
DFA [2:0] [Default: 000]		n-Ti 000 010 100 110		: Di : 3 : 5	isable times times	ed (1 5	etting time) time)	-	INA	00 01	01 11 01	: -	2 time 4 time 6 time Disat	es es	1 time	e)	
DFZ [2:0] [Default: 000]		n-Ti 000 010 100 110		: Di : 3 : 5	isable times times	ed (1	etting time) time)	-	INZ	Syste 00 01 10 11	01 11 01	: -	2 time 4 time 6 time Disat	es es	1 time	e)	
W/R			gister Vrite	Write	e/Rea	d Set 1:	tting Read										

#### Table 26. n-Times Matched Filter Activation Control Command

х

х

CRC

10. DMUX Setting Command This command allows the user to enable/disable and configure selected switch output on the DMUX terminal. The result of the chosen switch terminal's comparator is taken and output to DMUX using timing that depends on the monitoring method used.

Any switch input terminal can be connected to this DMUX pin by adjusting the DMX0 to DMX4 bits shown below.

				Tabl	le 27.	DML	JX Se	etting	Com	mano	ł							_
Command				R	egister	addres	ss						Setting	g data				
0:"L", 1:"H", x: don't care		39	38													24		
DMUX Setting	DMR	0	1 W/R 0 1 0 1 0 DMX4 DMX3 DMX2 DMX1 DMX0 x x x															
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0

31-27 bit	Selected Channel
00000	Disabled (Output is "L")
00001	INZ0
00010	INZ1
00011	INZ2
00100	INZ3
00101	INZ4
00110	INZ5
00111	INZ6
01000	INZ7
01001	INAO
01010	INA1
01011	INA2
01100	INA3
01101	INA4
01110	INA5
01111	INA6
10000	INA7
10001	INB0
10010	INB1
10011	INB2
10100	INB3
10101	INB4
10110	INB5
10111-11111	Disabled (Output is "L")

#### Table 28. DMUX Channel Selection

х

х

х

х

х х х

х

х

х

х

х

х

х

DMX [4:0] [Default: 00000]

**DMUX** Terminal Setting

00000 : Disabled (DMUX output is "L") 00001 - 10110 : Selected Channel 10110 - 11111 : Disabled (DMUX output is "L") Register Write/Read Setting 0: Write 1: Read

W/R

#### 11. Normal Mode Setting Command

This command allows the user to set the monitoring period, strobe time, and monitoring method of normal mode. The normal mode is set after power on reset or by "Monitor Mode Transition Command".

The monitoring period can be set individually per power supply system but the strobe time is common to all switch terminals.

The monitoring method can be set continuous monitoring, intermittent monitoring at the same time, sequential monitoring by power supply system and sequential monitoring of all switch terminals.

- Continuous Monitoring:
  - IC monitors switch status continuously.

Refer to the "[Basic Operation 1] Detection of switch status change (Continuous Monitoring)" section for additional details.

Intermittent Monitoring at the Same Time:

IC monitors switch status per power supply system at the same time.

Refer to the "[Extension Function1: Intermittent Monitoring at the Same Time (with Current Slope)]" section for additional details.

Sequential Monitoring by Power Supply System:

IC monitors switch status per switch by turns on power supply system.

Refer to the "[Extension Function 2: Sequential Monitoring by Power Supply System]" section for additional details. • Sequential Monitoring of All Switch Terminals:

IC monitors switch status per switch by turns. Refer to the "[Extension Function 3: Sequential Monitoring of All Switch Terminals]" section for additional details.

If both sequential and continuous monitoring are enabled at the same time, continuous monitoring will be the one implemented.

If both sequential monitoring by power supply system and sequential monitoring of all switch terminals are enabled at the same time, sequential monitoring of all switch terminals will be the one implemented.

Command				R	egister	addres	ss						Settin	g data				
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Normal Mode Setting	FMR	0	1	W/R	0	1	0	1	1	FSQ	FSQB	FSQA	FSQZ	FITB2	FITB1	FITB0	FITA2	
									Setting	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		FITA1	FITA0	FITZ2	FITZ1	FITZ0	SVW1	SVW0	FITB3	FITA3	FITZ3	х	х	х	х	х	х	CRC
FSQ [Default: 0]						quent Disab		onitor		f All S Enab		n Terr	ninals	5				
FSQB [Default: 0]						quent Disab		onitor		y Pov Enab		upply	y Syst	tem fo	or INE	3 Sys	tem	
FSQA [Default: 0]						quent Disab		onitor		y Pov Enab		upply	y Syst	tem fo	or IN/	A Sys	tem	
FSQZ [Default: 0]						quent Disab		onitor		y Pov Enab		upply	' Syst	tem fo	or INZ	Z Sys	tem	
FIT*[3:0] (*: B, A, Z)	[Defa	ault: O	000]		000 007 010 011		ontinu ns )ms )ms	riod f ıous l			00 00 01 01	001:2 011:1 01:3 101:5	0ms 80ms 0ms		ing p	rohib	ited	
SVW [1:0] [Default:	01]				00:	obe T 93.7 187.	5µs			: 125 : 250								
W/R						gister Vrite	Write	e/Rea		tting Reac	ł							

#### Table 29. Normal Mode Setting Command

12. Sleep Mode Setting Command This command allows the user to set the monitoring period and monitoring method of sleep mode.

The sleep mode is set by "Monitor Mode Transition Command".

The strobe time of sleep mode is the same as the normal mode.

About the monitoring period and monitoring method, refer to the "Normal Mode Setting Command" discussed in section 11 below.

Table 30. Sleep Mode Setting Command																		
Command				R	egister	addres	s			Setting data								
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Sleep Mode Setting	SMR	0	1	W/R	0	1	1	0	0	SSQ	SSQB	SSQA	SSQZ	SITB2	SITB1	SITB0	SITA2	
	1		Setting data														CRC	
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		SITA1	SITA0	SITZ2	SITZ1	SITZ0	х	х	SITB3	SITA3	SITZ3	х	х	х	х	х	х	CRC
SSQ [Default: 0] SSQB [Default: 0] SSQA [Default: 0] SSQZ [Default: 0]	0: Disabled 1: Enabled SSQB [Default: 0] 0: Disabled 1: Enabled SSQA [Default: 0] 0: Disabled 1: Enabled																	
SIT*[3:0] (*: B, A, Z) W/R	SIT*[3:0] (*: B, A, Z) [Default: 0111] W/R						Monitoring Period for Sleep Mode0000: Continuous Monitoring0001: 2.5ms0010: 5ms0011: 10ms0100: 20ms0101: 30ms0110: 40ms0111: 50ms1000: 100ms1001 – 1111: Setting prohibitedRegister Write/Read Setting0: Write1: Read											

# www.rohm.com © 2016 ROHM Co., Ltd. All rights reserved. TSZ22111 • 15 • 001

13. Detection Edge Selection Command

This command allows the user to configure interrupt trigger of switches for the INTB pin. The interrupt trigger can be set to only the falling edge (Note 19) or both the rising and falling edges of the switch input voltage per power supply system.

If only the falling edge is selected, the INTB pin not changes by the rising edges of switch input voltage.

(Note 19) If the INZ current "Source Setting" is enabled, the falling edge of the switch input terminal is seen when the external switch is turned on. If the INZ current "Sink Setting" is enabled, the falling edge is seen when the external switch is turned off.

Table 31. Detection Edge Selection Command																			
Command					R	egister	addres	s			Setting data								
0:"L", 1:"H",	0:"L", 1:"H", x don't care			38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Detection Edge Selection ISR		0	1	W/R	0	1	1	0	1	ISB	ISA	ISZ	х	х	х	х	х		
		Setting data																CRC	
			23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
			х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
ISA ISZ	[Default: [Default: [Default:	1]	Switch edge where interrupt occurs for INB System0: Only Falling Edge1: Both EdgesSwitch edge where interrupt occurs for INA System0: Only Falling Edge1: Both EdgesSwitch edge where interrupt occurs for INZ System0: Only Falling Edge1: Both Edges0: Only Falling Edge1: Both Edges																
W/R					gister Vrite	Write	e/Rea		ting Read										

Table 31. Detection Edge Selection	Command
Table 51. Detection Luge Delection	Johnmanu

#### 14. Automatic Mode Transition Command

This command allows the user to configure the mode to automatically change by a change in switch status. If the automatic transition is enabled, the monitoring period and monitoring method are changed to normal mode settings when it detects a change in switch status on sleep.

Refer to the "[Basic Operation 4] Sleep Mode Operation Automatic Transition to Normal Mode" section for additional details on how sleep mode operations works for this IC.

Command			Register address Setting data														
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24
utomatic Mode Transition	MIR	0	1	W/R	0	1	1	1	0	MR_IER	х	х	х	х	х	х	х
			Setting data														
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х

MR_IER [Default: 1]	Automatic Mode Transition								
	0: Disabled	1: Enabled							
W/R	Register Write/R	Read Setting							
	0: Write	1: Read							

15. Monitor Mode Transition Command

This command allows the user to change the mode of operation between normal and sleep. Refer to the "[Basic Operation 3] Sleep Mode Operation (Manual Transition)" section for additional details on how sleep mode operations works for this IC.

			Table	e 33.	Monit	or Mo	ode T	ransi	tion C	Comm	and							
Command	Command			R	egister	addres	ss											
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Monitor Mode Transition	MDR	0	1	W/R	0	1	1	1	1	MDC	х	х	х	х	х	х	х	
			Setting data												CRC			
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC
MDC [Default: 0]			Monitoring mode 0: Normal Mode 1: Sleep Mode															
W/R			Register Write/Read Setting 0: Write 1: Read															

#### Table 00 Mariles Marile Te -1

#### 16. Reset Command

This command allows the user to reset the registers to their initial settings. After the reset command has been sent, the physical interrupt pin goes to low (INTB="L").

				Ta	able 3	34. I	Rese	t Con	nman	d								
Command			Register address Setting data															
0:"L", 1:"H", x: don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
Reset RST			1	0	1	1	1	1	1	х	х	х	х	х	х	х	х	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	x	x	х	x	x	х	х	х	х	х	х	х	х	х	x	CRC

#### 17. TEST Command

This command is used to enter test mode, which is only possible when the TEST pin is "H".

Table 35. TEST Command																		
Command				Register address Setting data														
0:"L", 1:"H", x don't care		39	38	37	36	35	34	33	32	31	30	29	28	27	26	25	24	
TEST	TEST TSR		1	1	1	1	0	0	1	TSS7	TSS6	TSS5	TSS4	TSS3	TSS2	TSS1	TSS0	
									Settin	g data								CRC
		23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7-0
		х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	CRC

#### 18. Register Map

							Та	ble	36.	Re	giste	er N	lap														
Register Name	Symbol	Register Address												etting D ef*: Defa													CRC
		39:32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7:0
Null Command	IRC	0x40																									CRC
Interrupt Notification of Switch Change Setting Command	IER	0x41			IEB5 (def:1)	IEB4 (def:1)	IEB3 (def:1)	IEB2 (def:1)		IEB0 (def:1)	IEA7 (def:1)	IEA6 (def:1)	IEA5 (def:1)	IEA4 (def:1)	IEA3 (def:1)	IEA2 (def:1)	IEA1 (def:1)	IEA0 (def:1)	IEZ7 (def:1)	IEZ6 (def:1)	IEZ5 (def:1)	IEZ4 (def:1)		IEZ2 (def:1)	IEZ1 (def:1)		CRC
Comparator Operation Control Command	CMR	0x42			CMB5					CMB0			CMA5				CMA1			CMZ6					CMZ1		CRC
[Default: Valid] Comparator Threshold Selection Command	-		СТВ	CTA	(def:1) CTZ	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	(def:1)	
[Default: 3.0V]	CTR	0x43	(def:0)	(def:0)	(def:0)																						CRC
INZ Current Source/Sink Selection Command [Default: Source]	PUDR	0x44																	PUD7 (def:0)	PUD6 (def:0)	PUD5 (def:0)	PUD4 (def:0)			PUD1 (def:0)	PUD0 (def:0)	
Current Source Activation Command [Default: OFF (Invalid)]	CER	0x45	CEB (def:0)	CEA (def:0)	CEZ (def:0)																						CRC
Holding Current / Wetting Current Level Selection			CRH1	CRH0	LCB5	LCB4	LCB3	LCB2	LCB1	LCB0	LCA7	LCA6	LCA5	LCA4	LCA3	LCA2	LCA1	LCA0	LCZ7	LCZ6	LCZ5	LCZ4	LCZ3	LCZ2	LCZ1	LCZ0	<u>├</u> ─┦
Command (LSB) [Default: Wetting current =1mA (Holding current)]	LCR	0x46	(def:0)	(def:0)	(def:1)	(def:1)	(def:1)	(def:1)		(def:1)		(def:1)	(def:1)	(def:1)	(def:1)				(def:1)	(def:1)		(def:1)		(def:1)		(def:1)	CRC
Holding Current / Wetting Current Level Selection		0.47			MCB5	MCB4	MCB3	MCB2	MCB1	MCB0	MCA7	MCA6	MCA5	MCA4	MCA3	MCA2	MCA1	MCA0	MCZ7	MCZ6	MCZ5	MCZ4	MCZ3	MCZ2	MCZ1	MCZ0	0.00
Command (MSB) [Default: Wetting current =1mA (Holding current)]	MCR	0x47			(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	CRC
Wetting Current Operation Control Command	WTR	0x48			WTB5	WTB4				WTB0		WTA6 (def:0)		WTA4 (def:0)		WTA2		WTA0		WTZ6				WTZ2			CRC
[Default: Invalid] n-Times Matched Filter Activation Control Command	DFR	0x49	DFB2		(def:0) DFB0		(def:0) DFA1		DFZ2		DFZ0	(der:0)	(def:0)	(det:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)	CRC
[Default: Invalid] DMUX Setting Command			(def:0) DMX4	(def:0) DMX3	(def:0) DMX2	(def:0) DMX1	(def:0) DMX0	(def:0)	(def:0)	(def:0)	(def:0)															<u> </u>	
[Default: Invalid]	DMR	0x4A	(def:0)	(def:0)	(def:0)	(def:0)	(def:0)																				CRC
Normal Mode Setting Command [Default: Full-time monitor,Strobe time:125us, Sequential	FMR	0x4B	FSQ	FSQB	FSQA	FSQZ	FITB2		FITB0			FITA0	FITZ2	FITZ1	FITZ0		SVW0	FITB3	FITA3	FITZ3							CRC
monitor is invalid] Sleep Mode Setting Command			(def:0) SSQ	(def:0) SSQB	(def:0) SSQA	(def:0) SSQZ	(def:0) SITB2	(def:0) SITB1	(def:0) SITB0	(def:0) SITA2	(def:0) SITA1	(def:0) SITA0	(def:0) SITZ2	(def:0) SITZ1	(def:0) SITZ0	(def:0)	(def:1)	(def:0) SITB3	(def:0) SITA3	(def:0) SITZ3							
[Default: Monitor period:50ms,Sequential monitor is invalid]	SMR	0x4C	(def:0)	(def:0)	(def:0)	(def:0)		(def:1)		(def:1)		(def:1)	(def:1)	(def:1)	(def:1)			(def:0)	(def:0)	(def:0)							CRC
Detection Edge Selection Command [Default: Both edges]	ISR	0x4D	ISB (def:1)	ISA (def:1)	ISZ (def:1)																						CRC
Automatic Mode Transition Command		0.15	MR_	(001.1)	(001.1)																						0.00
[Default: Automatic transition is valid]	MIR	0x4E	IER (def:1)																								CRC
Monitor Mode Ttransition Command [Default: Normal mode]	MDR	0x4F	MDC (def:0)																								CRC
Reset Command	RST	0x5F																									CRC
Interrupt Notification of Switch Change Setting Command Read	RIER	0x61																									CRC
Comparator Operation Control Command Read	RCMR	0x62																									CRC
Comparator Threshold Selection Command Read	RCTR	0x63																									CRC
NZ Current Source/Sink Selection Command Read	RPUDR	0x64																									CRC
Current Source Activation Command Read	RCER	0x65																									CRC
Holding Current / Wetting Current Level Selection	RLCR	0x66																									CRC
Command (LSB) Read Holding Current / Wetting Current Level Selection	RMCR	0x67																									CRC
Command (MSB) Read Wetting Current Operation Control Command Read	RWTR	0x68																									CRC
n-Times Matched Filter Activation Control Command Read	RDFR	0x69																									CRC
DMUX Setting Command Read	RDMR	0x6A																									CRC
Normal Mode Setting Command Read	RFMR	0x6B																									CRC
Sleep Mode Setting Command Read	RSMR	0x6C																									CRC
Detection Edge Selection Command Read	RISR	0x6D																									CRC
Automatic Mode Transition Command Read	RMIR	0x6E																									CRC
Monitor Mode Ttransition Command Read	RMDR	0x6F																									CRC
TEST Command [Default: Invalid]	TSR	0x79	TSS7 (def:0)	TSS6 (def:0)	TSS5 (def:0)		TSS3 (def:0)			TSS0 (def:0)																	CRC

Register Name	Symbol													Read Da	ata Nam	e											CRC
-		39:32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7:0
Interrupt Notification of Switch Change Setting Command Read	RIER	"100", Interrupt Factor	0	0	IEB5 (def:1)	IEB4 (def:1)	IEB3 (def:1)	IEB2 (def:1)	IEB1 (def:1)	IEB0 (def:1)	IEA7 (def:1)	IEA6 (def:1)	IEA5 (def:1)	IEA4 (def:1)	IEA3 (def:1)	IEA2 (def:1)	IEA1 (def:1)	IEA0 (def:1)	IEZ7 (def:1)	IEZ6 (def:1)	IEZ5 (def:1)		IEZ3 (def:1)				CRC
Comparator Operation Control Command Read	RCMR	"100", Interrupt Factor	0	0	CMB5 (def:1)		CMB3 (def:1)	CMB2 (def:1)		CMB0 (def:1)					CMA3 (def:1)	CMA2 (def:1)		CMA0 (def:1)					CMZ3 (def:1)		CMZ1 (def:1)		CRC
Comparator Threshold Selection Command Read	RCTR	"100", Interrupt Factor	CTB (def:0)	CTA (def:0)	CTZ (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
NZ Current Source/Sink Selection Command Read	RPUDR	"100", Interrupt Factor	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0					PUD3 (def:0)				CRC
Wetting Current Operation Control Command Read	RCER	"100", Interrupt Factor				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Holding Current / Wetting Current Level Selection Command (LSB) Read	RLCR	Interrupt Factor			(def:1)		(def:1)		(def:1)	(def:1)		(def:1)	(def:1)	(def:1)	(def:1)		(def:1)	(def:1)	(def:1)	(def:1)	(def:1)		(def:1)	(def:1)		(def:1)	CRC
Holding Current / Wetting Current Level Selection Command (MSB) Read	RMCR	"100", Interrupt Factor	0	0	MCB5 (def:0)											MCA2 (def:0)							MCZ3 (def:0)				CRC
Wetting Current Operation Control Command Read	RWTR	"100", Interrupt Factor	0	0	WTB5 (def:0)																		WTZ3 (def:0)				CRC
n-Times Matched Filter Activation Control Command Read	RDFR	"100", Interrupt Factor	(def:0)	(def:0)		(def:0)			DFZ2 (def:0)			0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
DMUX Setting Command Read	RDMR	"100", Interrupt Factor			DMX2 (def:0)		DMX0 (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Normal Mode Setting Command Read	RFMR	"100", Interrupt Factor					FITB2 (def:0)				FITA1 (def:0)					SVW1 (def:0)			FITA3 (def:0)		0	0	0	0	0	0	CRC
Sleep Mode Setting Command Read	RSMR	"100", Interrupt Factor	SSQ (def:0)		SSQA (def:0)							SITA0 (def:1)			SITZ0 (def:1)	0	0		SITA3 (def:0)		0	0	0	0	0	0	CRC
Detection Edge Selection Command Read	RISR	"100", Interrupt Factor	ISB (def:1)	ISA (def:1)	ISZ (def:1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Automatic Mode Transition Command Read	RMIR	"100", Interrupt Factor	MR_ IER (def:1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC
Monitor Mode Ttransition Command Read	RMDR	"100", Interrupt Factor	MDC (def:0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	CRC

#### Table 37. Register Map (SO Bit Alignment)

## **Typical Performance Curves**

Unless otherwise specified, VPUA=VPUB=13V, VDDI=5V, LVDD=AVDD=REF5 Series products (BD3375MUV-M/BD3375KV-C) use the same data.

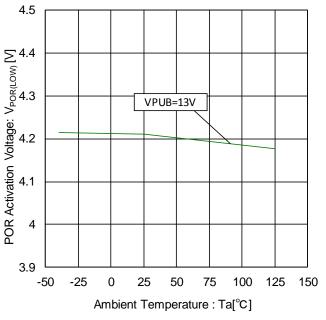
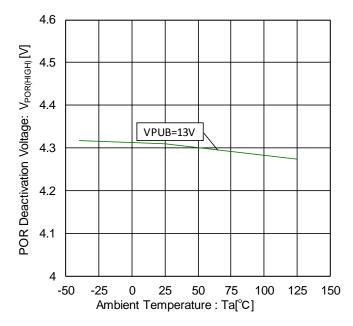
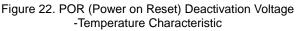
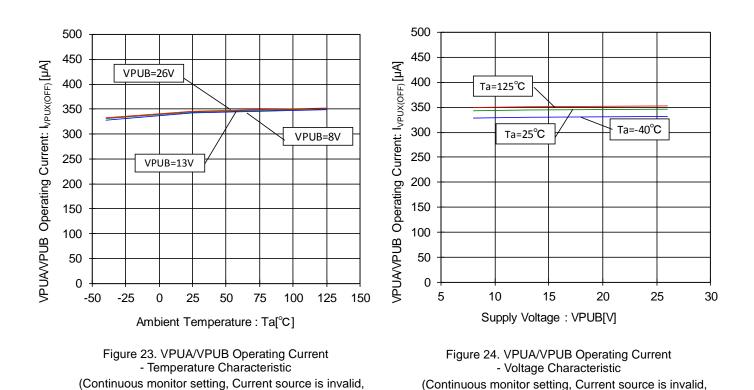


Figure 21. POR (Power on Reset) Activation Voltage - Temperature Characteristic

"Hi-Z" Status)







"Hi-Z" Status)

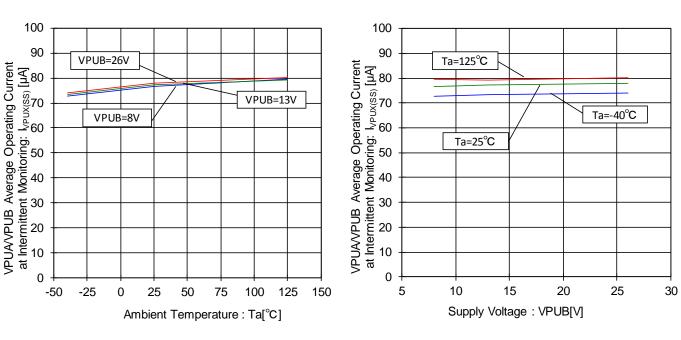
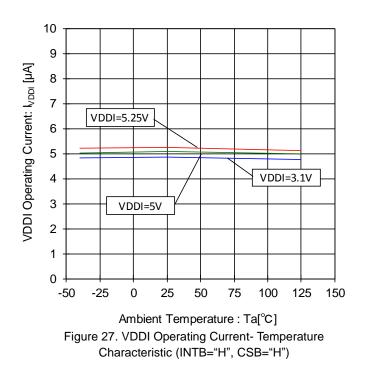
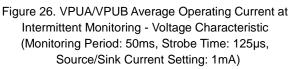
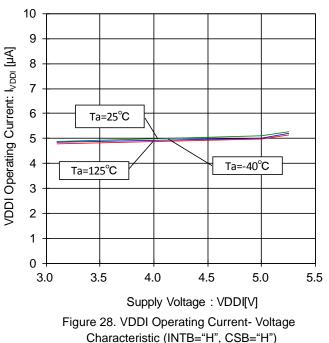
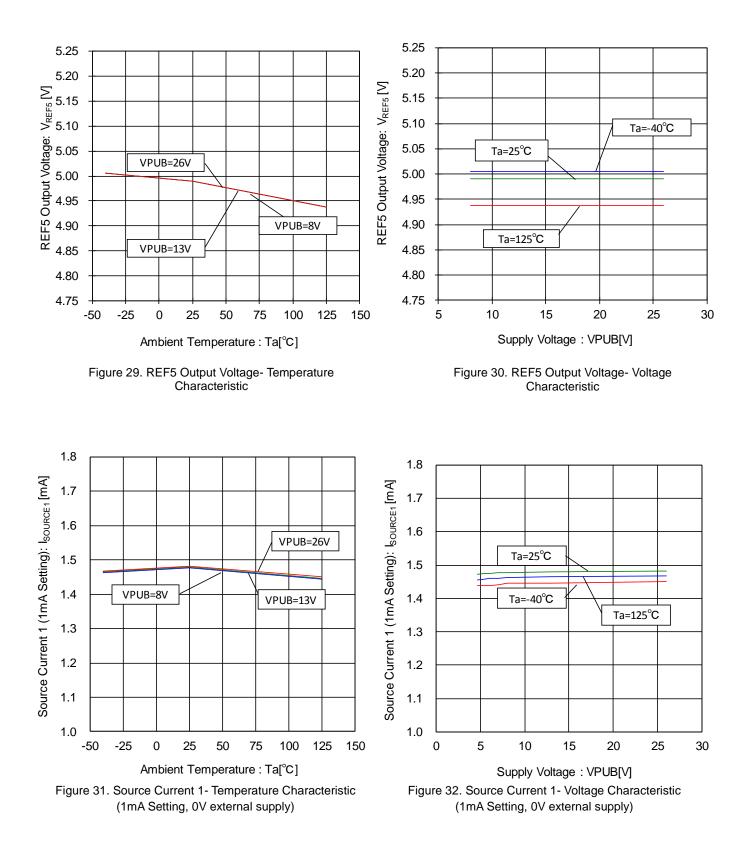


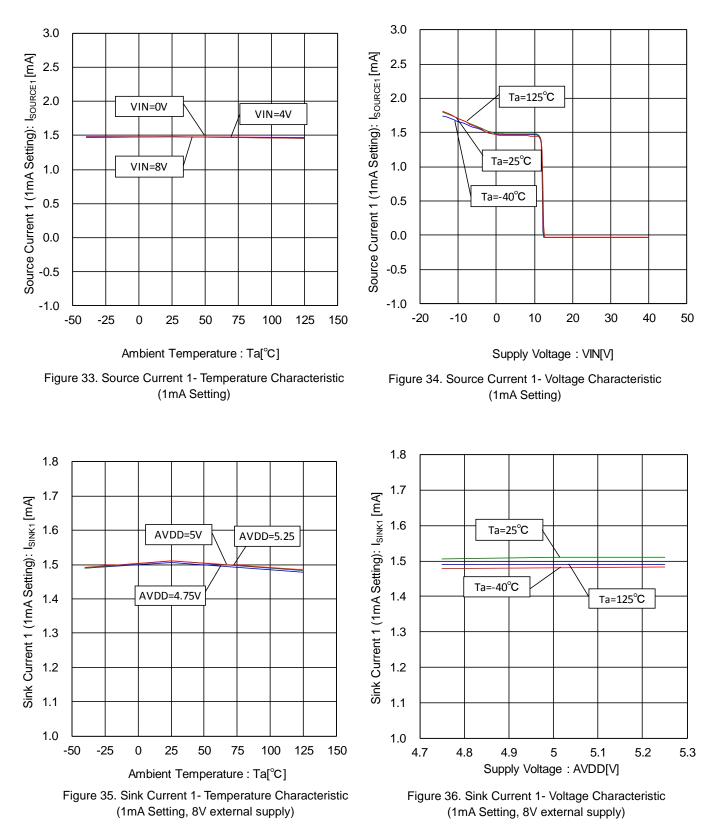
Figure 25. VPUA/VPUB Average Operating Current at Intermittent Monitoring - Temperature Characteristic (Monitoring Period: 50ms, Strobe Time: 125µs, Source/Sink Current Setting: 1mA)

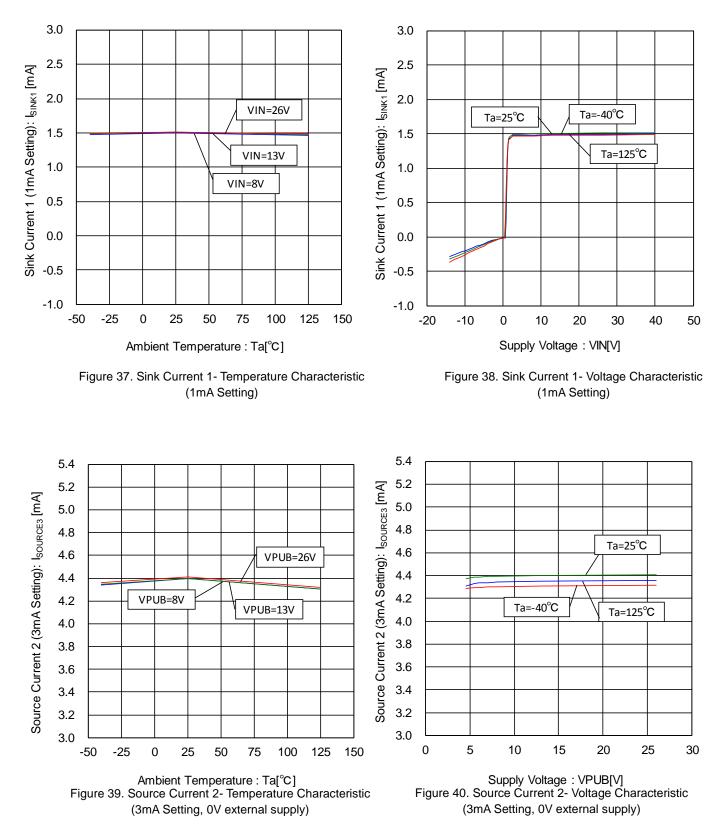


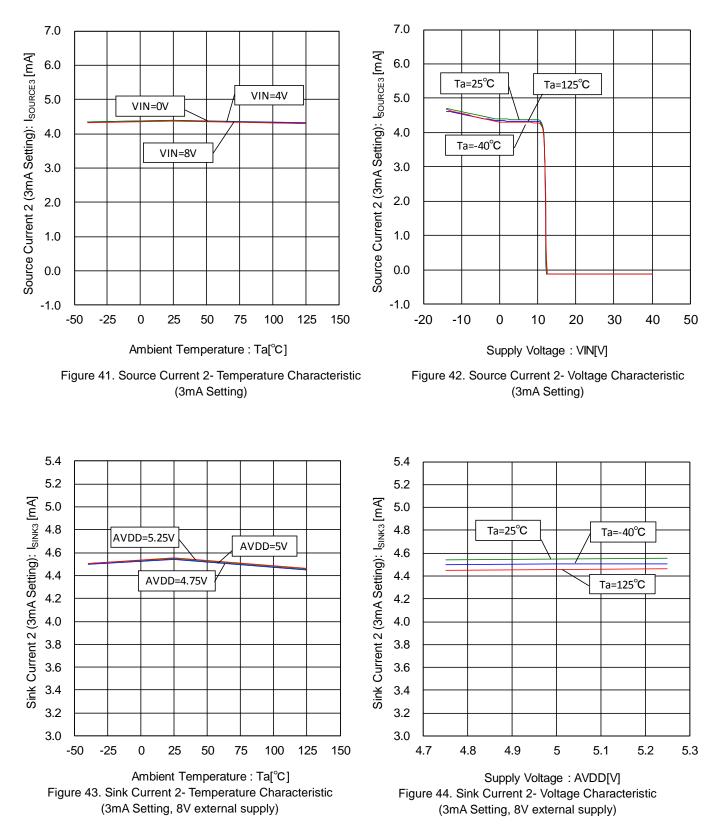


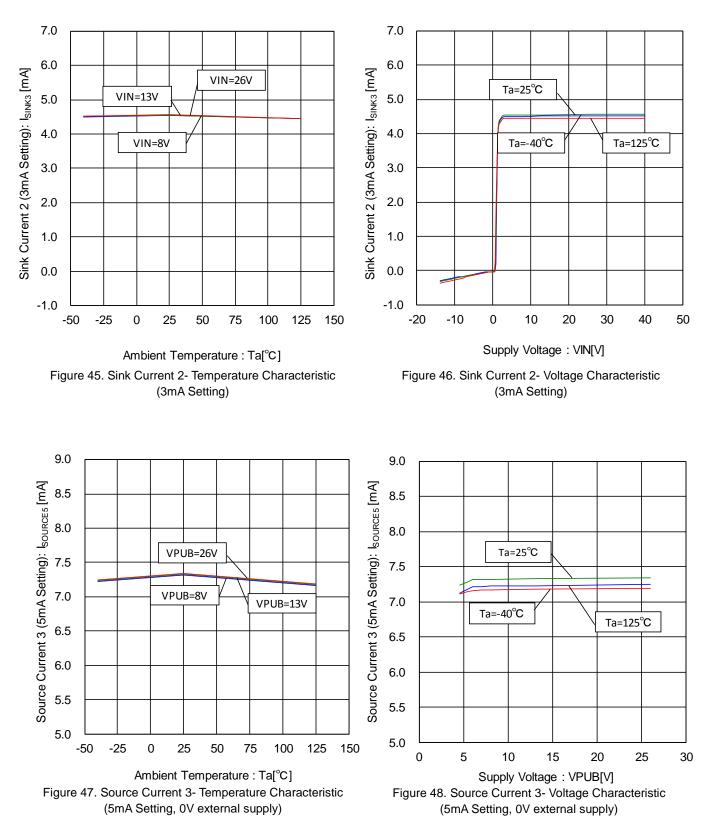


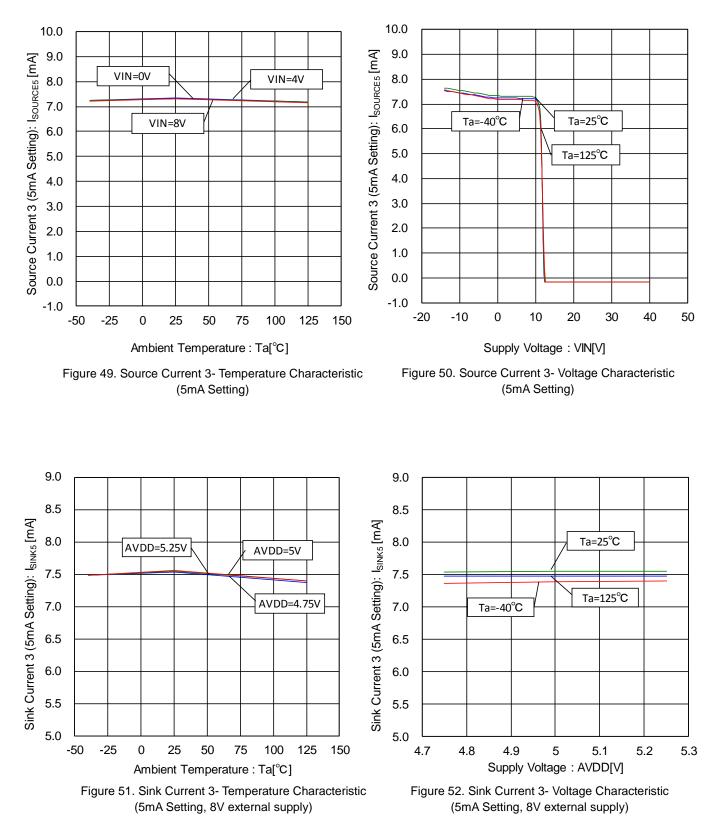


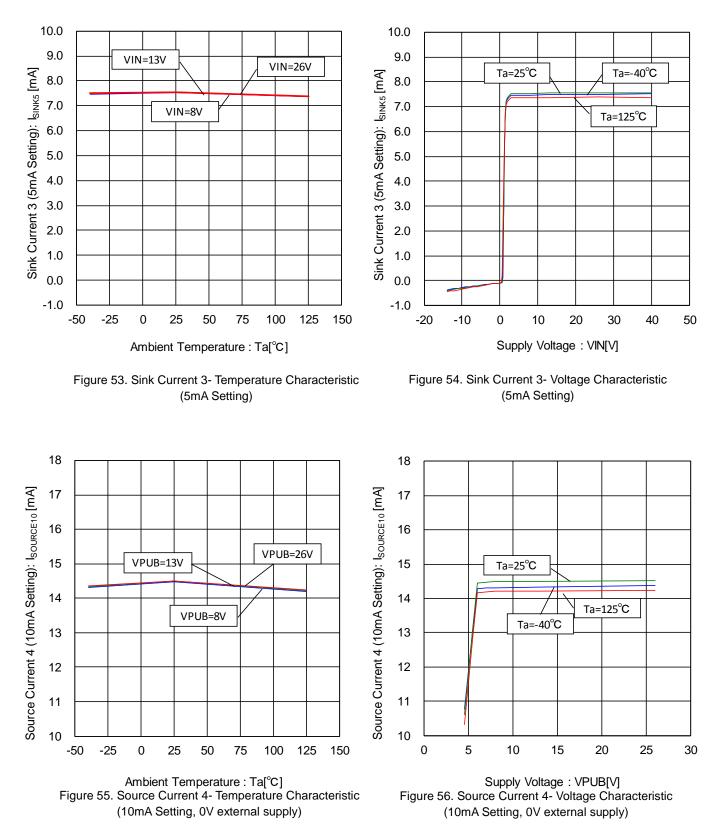


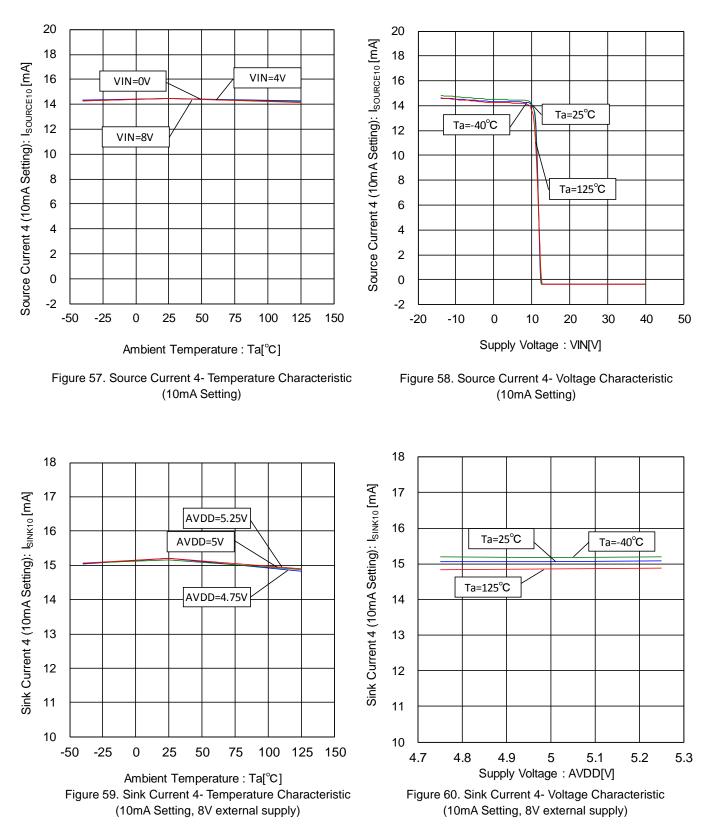


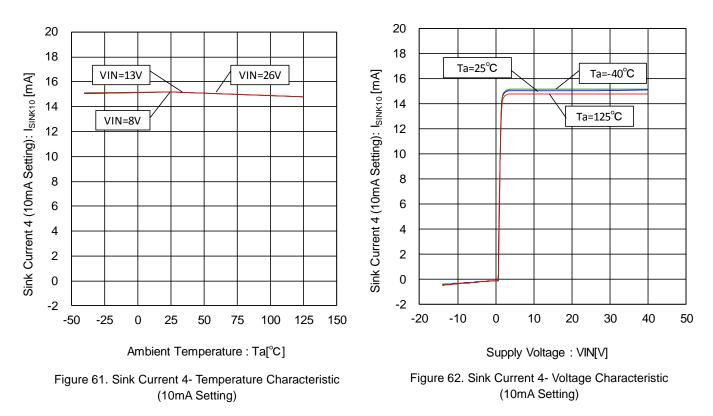


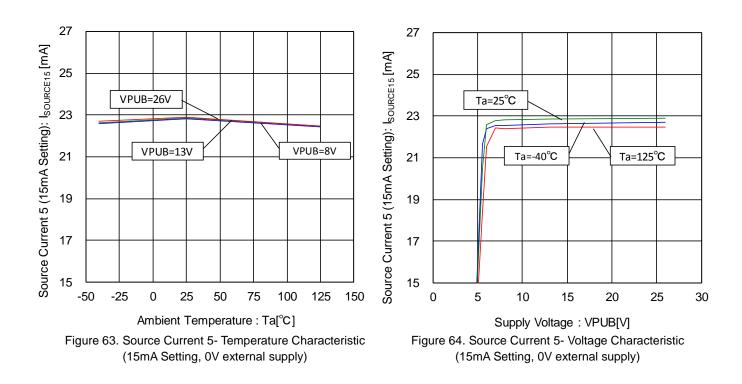


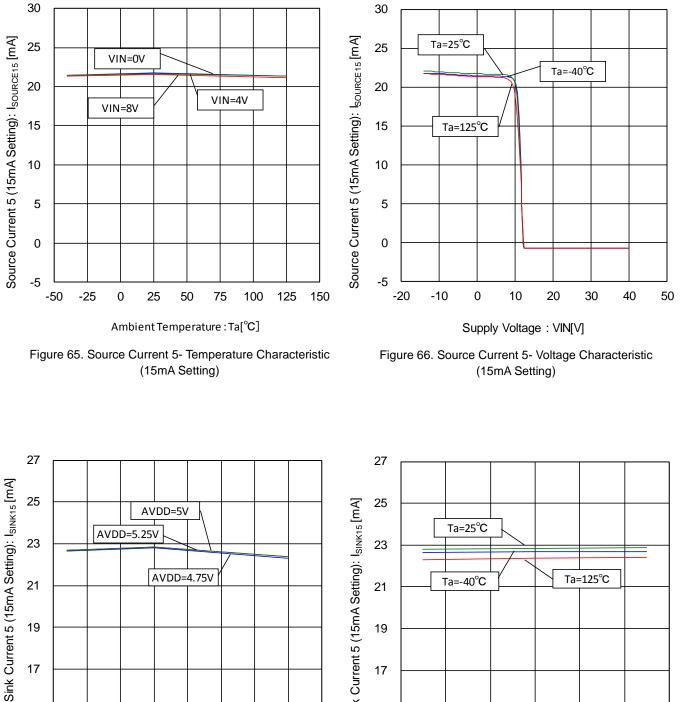


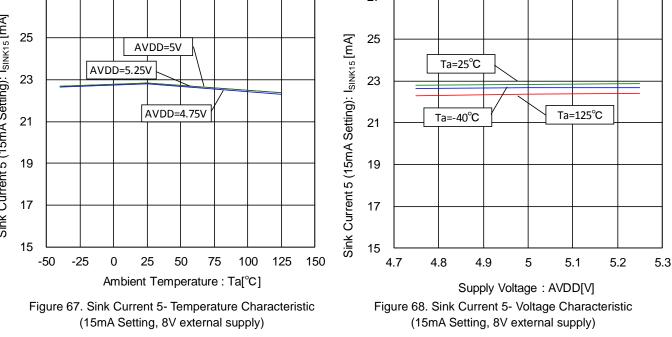


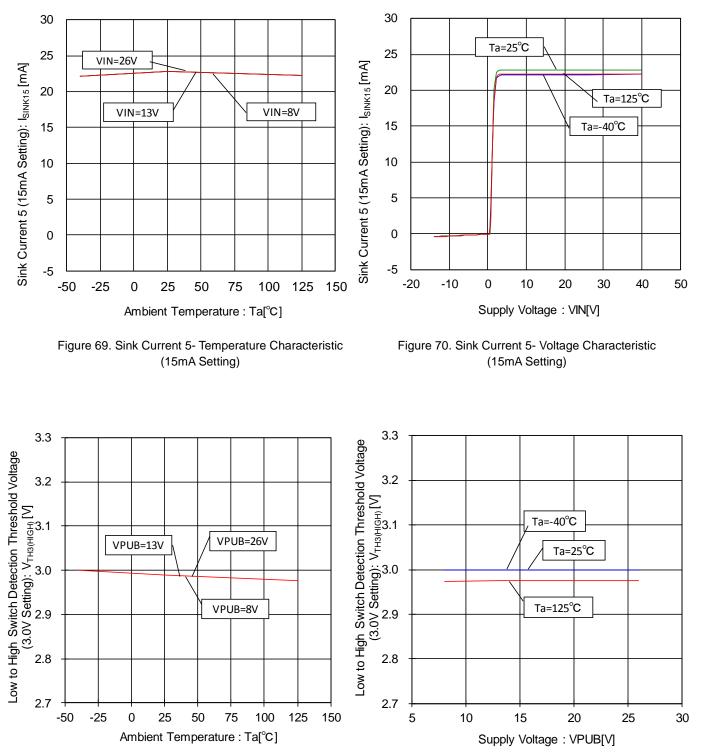


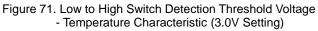


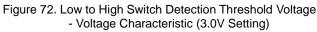












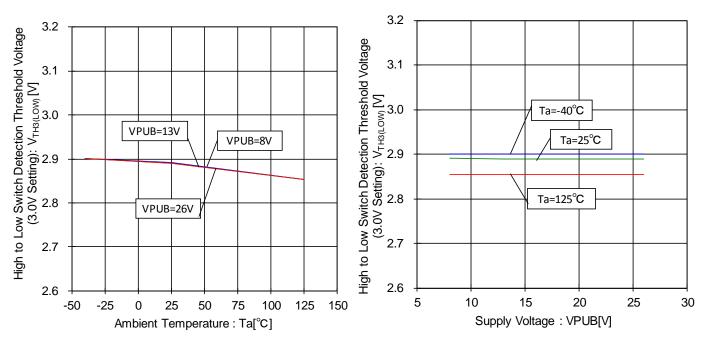
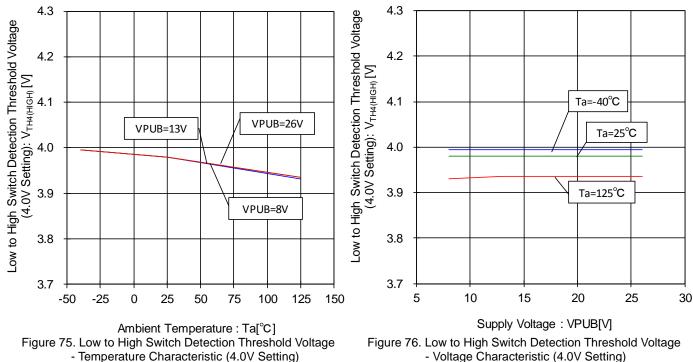


Figure 73. High to Low Switch Detection Threshold Voltage - Temperature Characteristic (3.0V Setting)





- Temperature Characteristic (4.0V Setting)

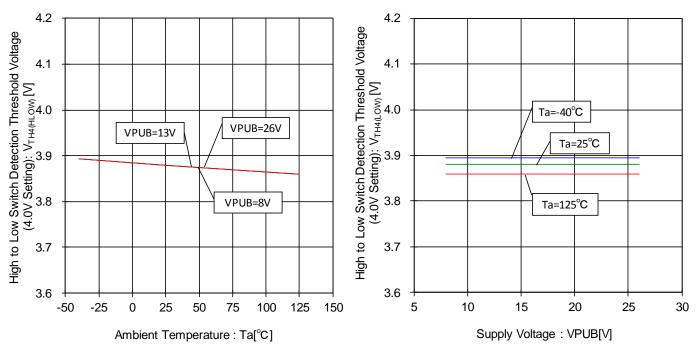
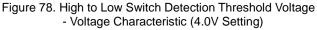
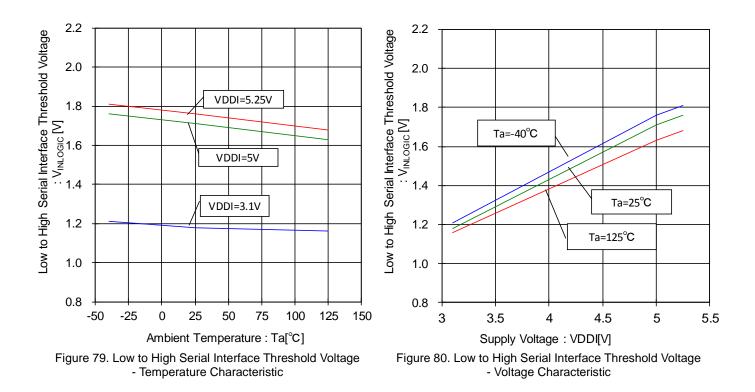
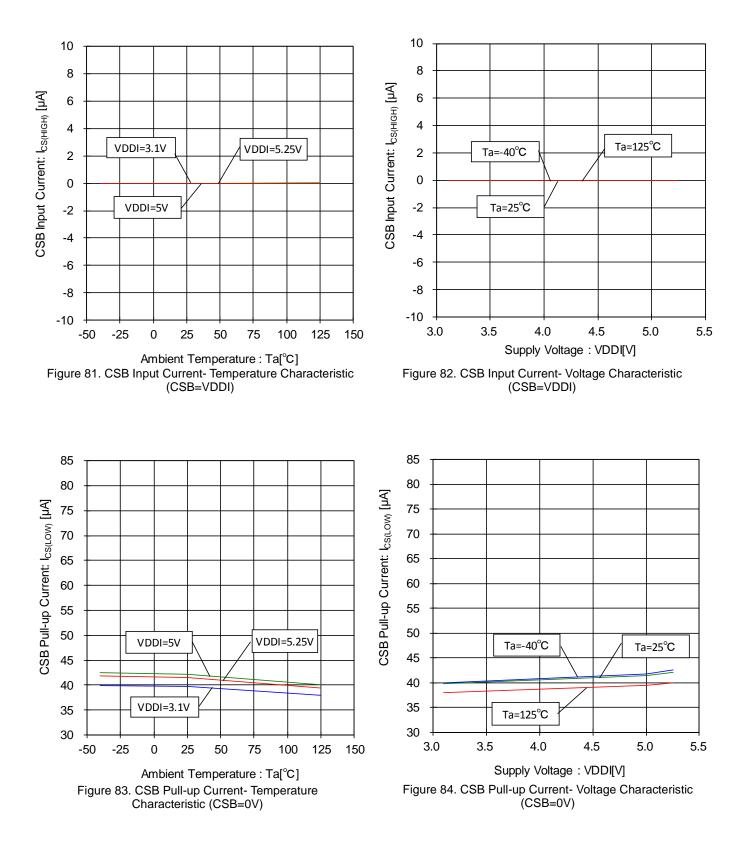
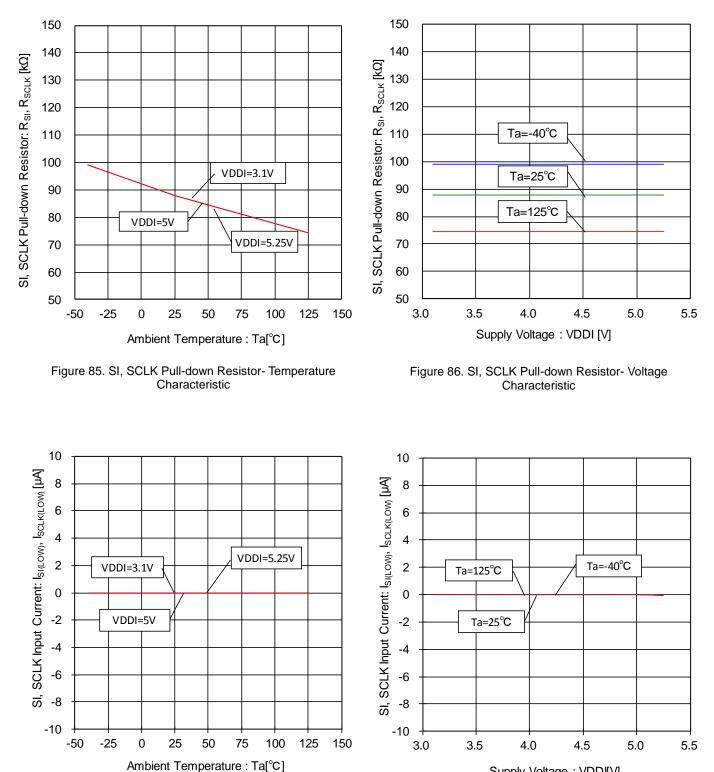


Figure 77. High to Low Switch Detection Threshold Voltage - Temperature Characteristic (4.0V Setting)





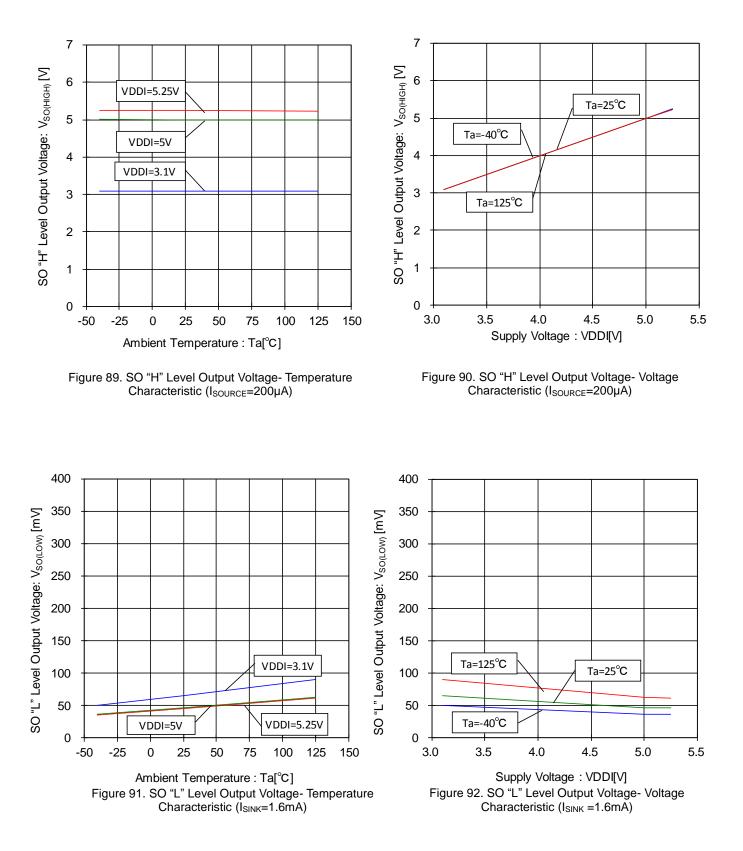




Supply Voltage : VDDI[V] Figure 88. SI, SCLK Input Current- Voltage Characteristic (SI, SCLK=0V)

Figure 87. SI, SCLK Input Current- Temperature

Characteristic (SI, SCLK=0V)



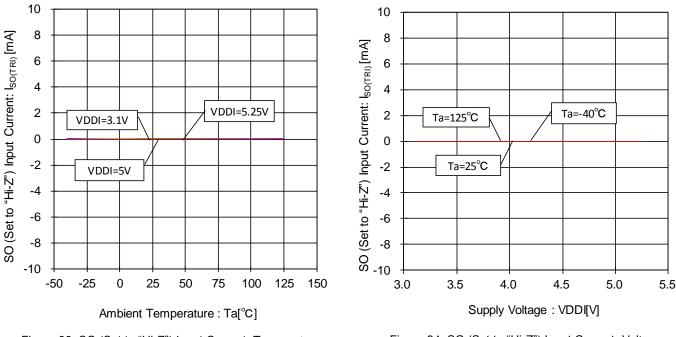
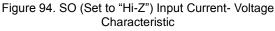


Figure 93. SO (Set to "Hi-Z") Input Current- Temperature Characteristic



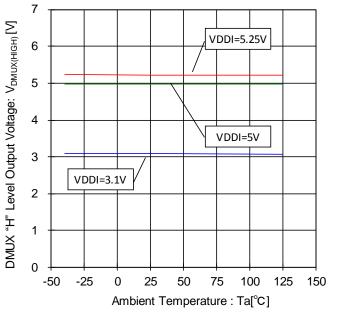
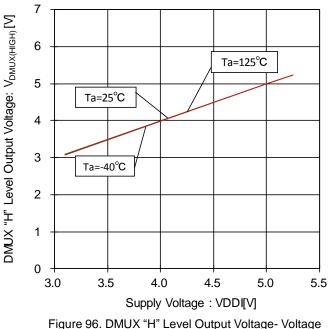


Figure 95. DMUX "H" Level Output Voltage- Temperature Characteristic (I<sub>SOURCE</sub>=200µA)



Characteristic (I<sub>SOURCE</sub>=200µA)

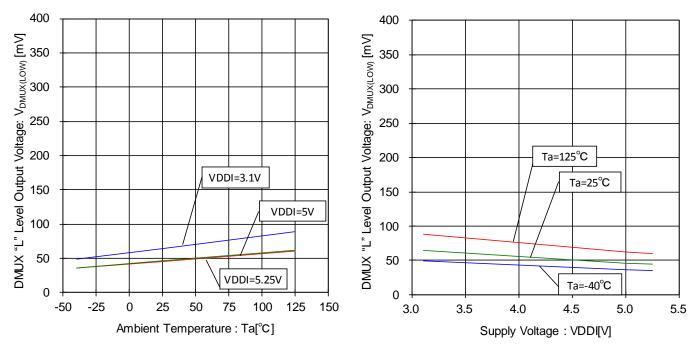
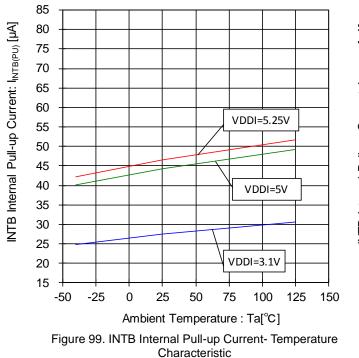
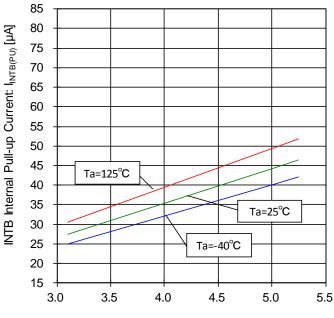


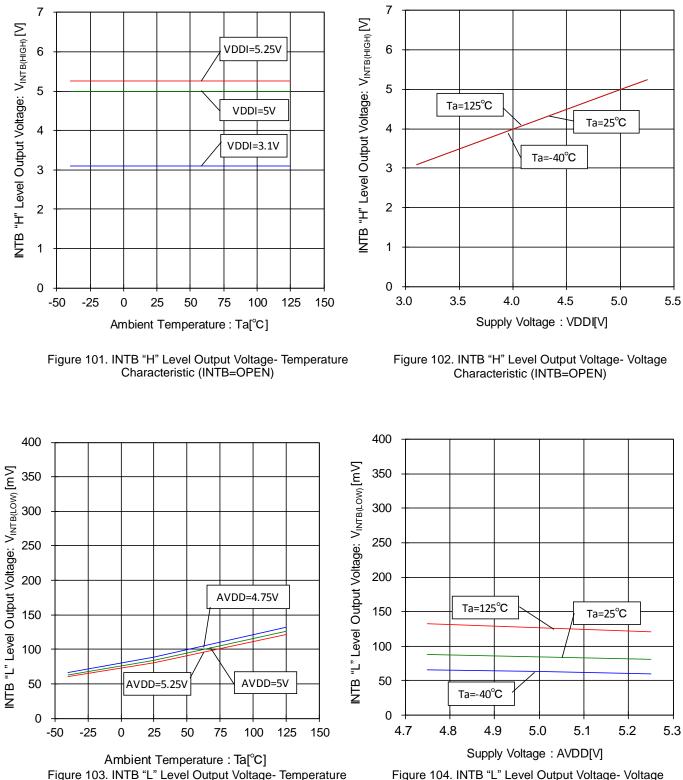
Figure 97. DMUX "L" Level Output Voltage- Temperature Characteristic (I<sub>SINK</sub>=1.6mA)

Figure 98. DMUX "L" Level Output Voltage- Voltage Characteristic (I<sub>SINK</sub>=1.6mA)



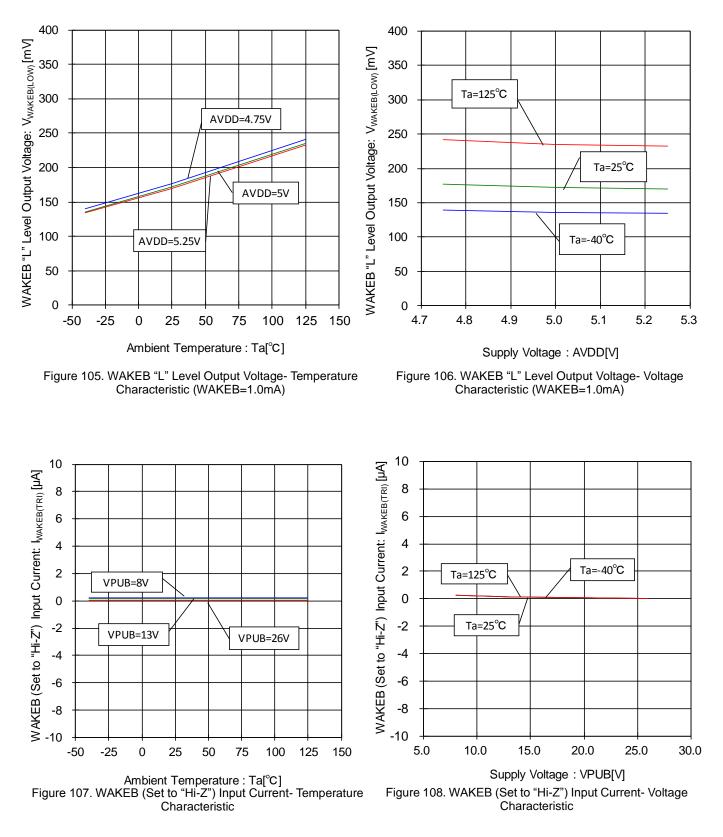


Supply Voltage : VDDI[V] Figure 100. INTB Internal Pull-up Current- Voltage Characteristic



Temperature Figure 104. INTB "L" Level Output Voltage- Voltage Characteristic (I<sub>SINK</sub>=1.0mA)

Characteristic (ISINK=1.0mA)



5.3

5.2

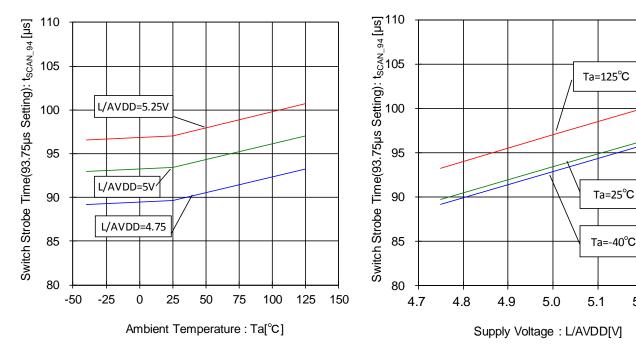
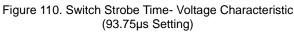
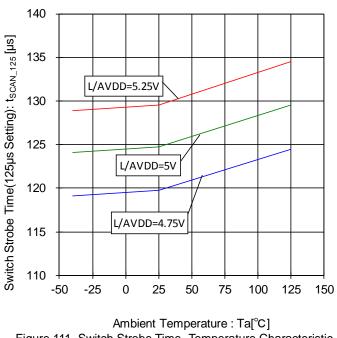
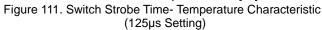


Figure 109. Switch Strobe Time- Temperature Characteristic (93.75µs Setting)







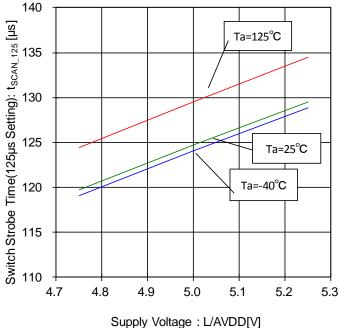
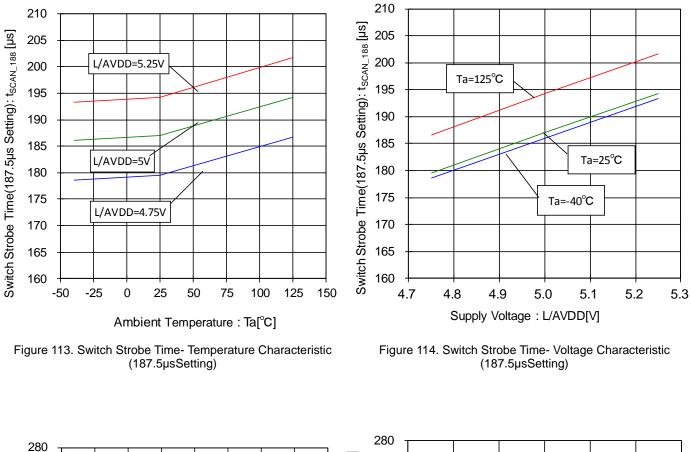
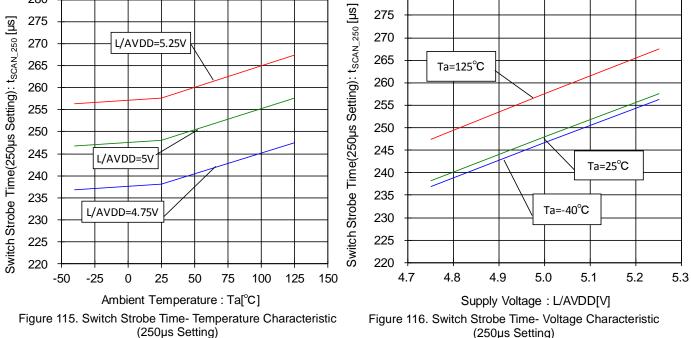
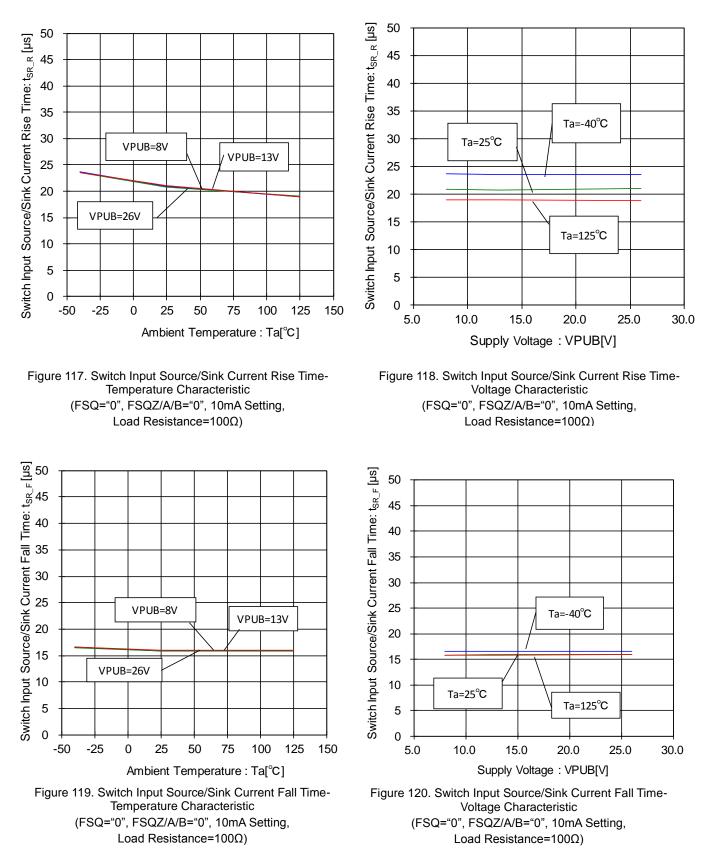


Figure 112. Switch Strobe Time- Voltage Characteristic (125µs Setting)







www.rohm.com © 2016 ROHM Co., Ltd. All rights reserved. TSZ22111 • 15 • 001

# Application Circuit Examples

1. Example of Application Circuit and its External Components

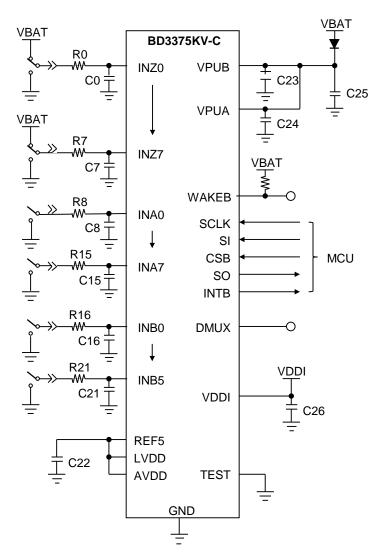


Figure 121. Example of Application Circuit and its External Components

- Capacitor (C23, C24, C26) at Power Supply Pins (VPUA, VPUB, VDDI) Insert a 0.1µF capacitor between each power supply pin (VPUA, VPUB, and VDDI) and ground. Make sure to design the external components with sufficient margin for the intended application. It is recommended to use capacitors with excellent voltage and temperature characteristics.
- Capacitor (C22) at REF5

In order to prevent oscillation, a capacitor needs to be placed between the REF5 output pin and ground. It is recommended to use a capacitor (electrolytic, tantalum, or ceramic of at least  $4.7\mu$ F). Make sure that capacitance of  $4.7\mu$ F or higher is maintained at the intended operating supply voltage and temperature range. Temperature change can cause fluctuation in capacitance, which may lead to oscillation. If a ceramic capacitor is chosen, it is recommended to use X5R, X7R, or any others with better temperature and DC biasing characteristics and higher voltage tolerance.

· Capacitor(C0 to C21) at Switch Pin (INZ, INA, INB)

It is recommended to use at least 0.1µF capacitors as protection against ESD. Make sure to design the external circuit with sufficient margin for the intended application. Use capacitors with application specific voltage and temperature characteristics.

Resistor (R0 to R21) at Switch Pin (INZ, INA, INB)
 Choose the appropriate resistor to reduce EMI noise. Design the circuit so the pin voltage does not fall below the threshold voltage defined by ground float of [Load Resistance] x [Wetting Current] (when wetting current is set to source) or voltage drop (when wetting current is set to sink) may occur.

2. Example of Parallel Connection Circuit

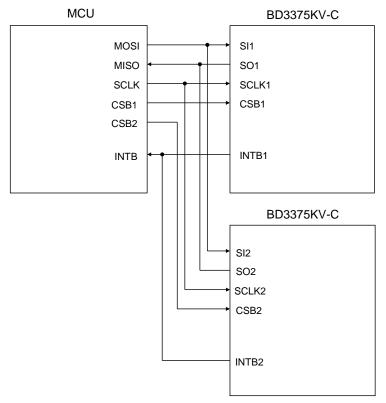
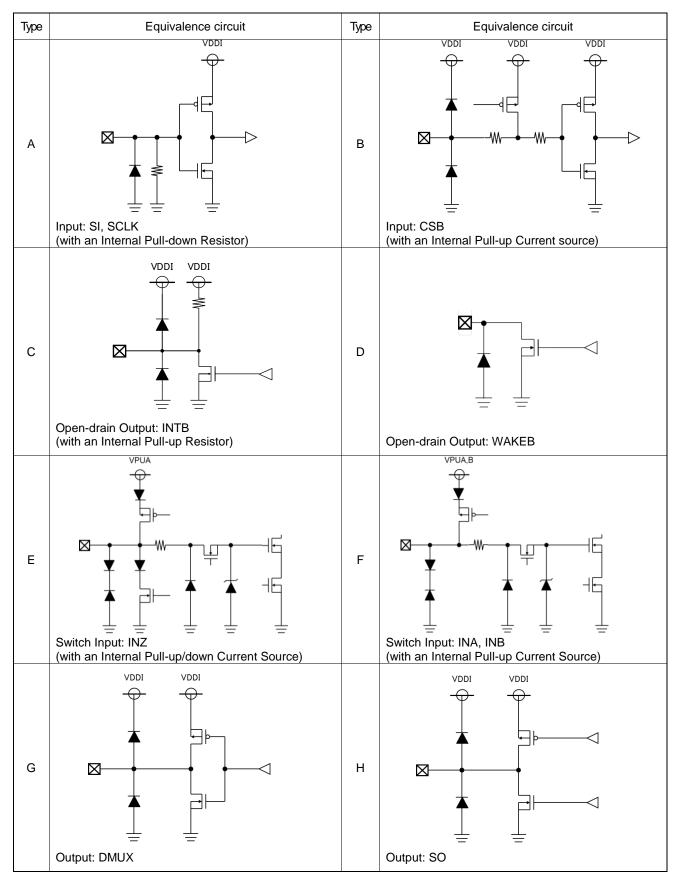


Figure 122. Example of Application Circuit and its External Components

Parallel Connection

Please prepare CSB terminals respectively.

# I / O Equivalence Circuit



# I / O Equivalence Circuit

Туре	Equivalence circuit	Туре	Equivalence circuit
1	VPUB VPUB	J	AVDD
			(with an Internal Pull-down Resistor)

# **Operational Notes**

#### 1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

#### 2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

#### 3. Ground Voltage

Except for pins the output and the input of which were designed to go below ground, ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

#### 4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

#### 5. Thermal Consideration

Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the maximum junction temperature rating.

#### 6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

#### 7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

#### 8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

#### 9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

#### 10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

#### 11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

## **Operational Notes – continued**

#### 12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

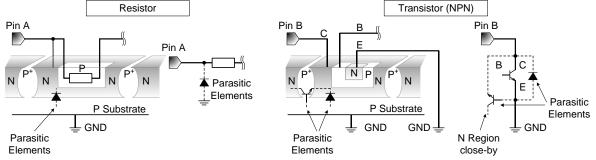


Figure 123. Example of monolithic IC structure

#### 13. Ceramic Capacitor

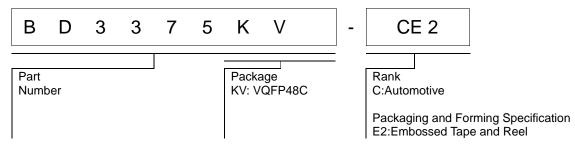
When using a ceramic capacitor, determine the dielectric constant considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

#### 14. Thermal Shutdown Circuit(TSD)

This IC has a built-in thermal shutdown circuit that prevents heat damage to the IC. Normal operation should always be within the IC's maximum junction temperature rating. If however the rating is exceeded for a continued period, the junction temperature (Tj) will rise which will activate the TSD circuit that will turn OFF all output pins. When the Tj falls below the TSD threshold, the circuits are automatically restored to normal operation.

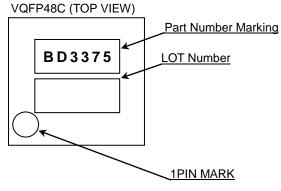
Note that the TSD circuit operates in a situation that exceeds the absolute maximum ratings and therefore, under no circumstances, should the TSD circuit be used in a set design or for any purpose other than protecting the IC from heat damage.

# **Ordering Information**





# Marking Diagrams (Top View)





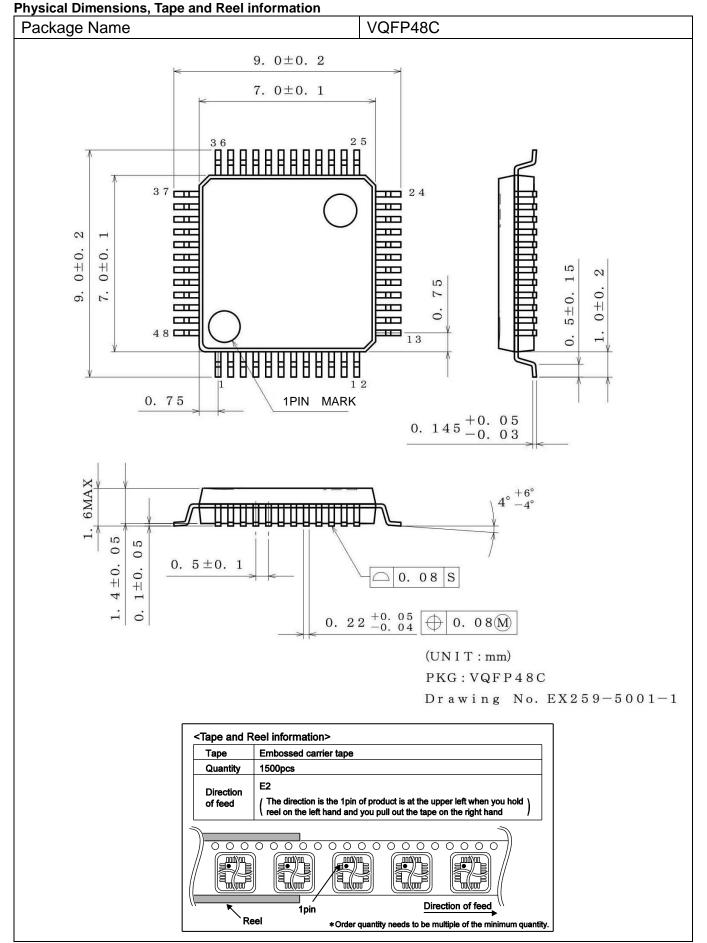


Figure 126. Physical Dimensions, Tape and Reel information

# **Revision History**

Date	Rev.	History
29.Jan.2016	001	(Japanese Only)
27.Sep.2016	002	New Release

# Notice

#### **Precaution on using ROHM Products**

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA			
CLASSI	CLASSⅢ	CLASS II b				
CLASSⅣ	CLASSI	CLASSⅢ	CLASSⅢ			

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

#### Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

#### **Precaution Regarding Intellectual Property Rights**

- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
- 3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

#### **Other Precaution**

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- 3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

#### **General Precaution**

- 1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ROHM Semiconductor: BD3375KV-CE2



Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;

- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);

- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;

- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком):

- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный) Факс: 8 (812) 320-03-32 Электронная почта: ocean@oceanchips.ru Web: http://oceanchips.ru/ Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А